## 5 Simulation of strain

5.1 Theory ................................................. 53
5.2 Models section parameters .............................. 53
   5.2.1 Substrate boundary condition ..................... 54
   5.2.2 External pressure boundary condition ............. 54
   5.2.3 Extended device boundary condition ............... 55
5.3 Solver parameters ....................................... 55
   5.3.1 Structure with a substrate ....................... 55
   5.3.2 Structure without a substrate (freestanding) .... 55
   5.3.3 Additional parameters .......................... 56
5.4 Physics section parameters ............................. 58
5.5 Output .................................................. 58

## 6 Drift-diffusion simulation of electrons and holes

6.1 Theory .................................................. 61
6.2 Plot variables .......................................... 61
6.3 Models section .......................................... 61
   6.3.1 Recombination models ............................. 63
   6.3.2 Thermoelectric power models ...................... 66
   6.3.3 Mobility models .................................. 67
   6.3.4 Boundary conditions ............................. 69
6.4 Physics section .......................................... 71
   6.4.1 Simple semiconductor model ....................... 72
   6.4.2 Default semiconductor model ...................... 72
   6.4.3 Special options for Schrödinger-Poisson calculations ............................. 72
6.5 Solver section .......................................... 73
   6.5.1 Parameters for PETSc solvers ...................... 75
   6.5.2 Parameters for the TiberCAD nonlinear solver .... 76
   6.5.3 Parameters for the PARDISO linear solver .......... 76

## 7 Heat Balance simulation

7.1 Heat equation ............................................ 77
7.2 Physical model .......................................... 77
   7.2.1 Electron and hole dissipations .................... 78
   7.2.2 Boundary conditions ................................ 79
7.3 Output data .............................................. 80

## 8 Envelope Function Approximation

8.1 Models section parameters .............................. 83
8.2 Solver parameters ........................................ 84
CONTENTS

8.2.1 Eigenvalue problem parameters ...................................... 84
8.2.2 Schrödinger equation parameters .................................... 85
8.3 Physical Models parameters ................................................ 85
8.4 Output ................................................................. 86

9 Simulation opticskp .............................................................. 87
  9.1 Output ................................................................. 88

10 Simulation opticalspectrum ..................................................... 89
  10.1 Output ................................................................. 90

11 Quantum dispersion ................................................................. 91
  11.1 Solver options ........................................................... 91
  11.2 Output ................................................................. 92

12 Quantum Density ................................................................. 93
  12.1 Output ................................................................. 94

Bibliography ................................................................. 95
Installation instructions

In the following, VERSION denotes the version number of the TIBERCAD release you downloaded and INSTALLPATH denotes the directory where TIBERCAD gets installed. Version 2.3.0 of GMSH (http://www.geuz.org/gmsh) will be installed together with TIBERCAD. For the Linux version of GMSH you need OpenGL libraries installed on your system.

Prerequisites

Get the installer package for your OS/architecture from http://www.tibercad.org or by contacting support@tibercad.org. Table 1 lists the packages available for download. To run TIBERCAD you will also need a license file that you will have to copy into the installation directory of TIBERCAD.

In the Windows version, some graphical features such as graphical convergence monitors are only available if an X Window server is installed and running.

Windows installation procedure

To install TIBERCAD in Windows, run the setup program tibercad-version_setup.exe. During the installation you can choose the installation directory. After finishing installation, copy your license file (tibercad.lic) into the license subdirectory of the TIBERCAD installation directory (INSTALLPATH/license), without changing its filename.

<table>
<thead>
<tr>
<th>installer package name</th>
<th>Target architecture</th>
</tr>
</thead>
<tbody>
<tr>
<td>tibercad-version_setup.exe</td>
<td>Windows 32-bit</td>
</tr>
<tr>
<td>tibercad-version_installer.bin</td>
<td>Linux 32-bit self-extracting installer</td>
</tr>
</tbody>
</table>

Table 1: Installer packages
Linux installation procedure

To install TiberCAD in Linux, download and run the self-extracting installer `tibercad-version_installer.bin` and follow the installation instructions.

After installation, copy your license file (tibercad.lic) into the ‘license’ subdirectory of the TiberCAD installation directory (`INSTALLPATH/license`) without changing the file-name. You can also provide the license file during installation.

The standard method to launch TiberCAD is by means of a shell script that is installed alongside the TiberCAD executable. It takes care of setting all necessary environment variables. If for some reason you have to run the executable directly, remember to set `TIBERCADROOT` to the TiberCAD installation directory (`INSTALLPATH`).

Quick start guide

In the ‘examples’ subdirectory you can find several examples ready to run. They are the same as the tutorials on `http://www.tibercad.org/documentation/tutorial/list`.

Windows

Open Windows Explorer and go to the TiberCAD installation directory. If you have write permission in the installation directory, you can browse to an examples directory and start the simulation by double clicking the input file, e.g. bulk.tib in Example_0. If not, copy the whole directory to a location in your personal area and run the examples from there.

If you cannot run TiberCAD by double clicking an input file (*.tib), then the input files are probably not correctly associated with the TiberCAD executable. In this case, try to establish the association by right-clicking the input file, choosing `open with... → Choose Program... → Browse...`, browsing to the TiberCAD installation directory and choosing the TiberCAD executable, `tibercad.exe`. A directory containing the simulation results will be created with the name provided in the input file.

Linux

After the correct installation of TiberCAD you should be able to run TiberCAD from the command line using the command `tibercad`. If not, you probably have to add the `bin` subdirectory of the TiberCAD installation directory to your `PATH` environment variable or start the TiberCAD executable using the absolute path (`INSTALLPATH/bin/tibercad`). Copy the directory of the example you want to run, e.g. bulk_Si, to your home directory or any place you have write permissions for. Change to the newly created directory and run TiberCAD by (assuming Example_0)
$ tibercad bulk.tib

A directory containing the simulation results will be created with the name provided in the input file.

**Bug reports / Feedback**

Please send bug reports, feedback or suggestions to support@tibercad.org. When submitting bug reports, please always include the full version number of TiberCAD you are running. The full version number appears in the first line of output when running the program:

$ tibercad

TiberCAD version 1.0.0-961

Usage: tibercad <inputfile>
Chapter 1

Overview

1.1 Introduction to numerical simulation with Tiber-CAD

TiberCAD is a multiphysics software tool; it comprises a set of solvers, called simulation models, each one describing a physical problem to be solved, e.g. DriftDiffusion (to solve Poisson and DriftDiffusion equations), EFASchroedinger (to solve Schroedinger equation in envelope function approximation), Macrostrain (to calculate macroscopical strain with an elastic model) and others.

Similarly to other device CADs, TiberCAD requires that one follows a three-step procedure.

In a first step the device geometry must be sketched, giving all the geometrical information needed by the simulations. This can be performed by means of a text file or with the help of a graphical tool. During this procedure one or more mesh regions and boundary regions have to be defined: in a following stage the mesh regions will be associated to materials and boundary regions to device contacts (boundary conditions in general).

The second step consists in running a mesher tool, which reads the geometry file and sets up the computational mesh used to discretize the partial differential equations representing the physical models to be solved. For this procedure TiberCAD makes use of the GPL software gmsh. Optionally, mesh output provided by other meshers, such as the one included in ISE-TCAD tool, are also supported. The output of the meshing procedure is a mesh file that contains information about the space discretization as well as the mesh regions and the boundary regions.

In the last step the actual simulations are performed. Together with the mesh information (comprised in the mesh file), TiberCAD requires an input file which associates materials to mesh regions, defines the physical properties and physical models to be
applied, and the type of calculations to be performed.

Here we deal primarily with the TiberCAD input file. However, in discussing examples of 1D, 2D and 3D simulations, we will also describe in some detail the geometry input files used to run \textit{gmsh}.

\subsection*{1.1.1 Input file structure}

TiberCAD input file is a text file which includes a description of the device structure, the definition of the solvers to be executed, with all the relevant physical and numerical parameters for each of them.

The input file is organized into several sections, each describing a different aspect of the problem to be solved. The strategy employed is similar to other commercial T-CAD tools and requires some practice to reach a good level of familiarity. We strongly suggest to read first the following chapters (Getting Started 1 and 2) in this manual and then study the input files provided in the examples directory and try to modify them, before writing your own input file from scratch. The example files touch all current features implemented in the code.

Let’s see an overview of the main features of the input file. The core of the input file comprises three sections, called \textbf{Device}, \textbf{Models} and \textbf{Simulation}:

\begin{verbatim}
$Device
{
 Region Si_channel
 {
 material= Si
 doping = 1e16
 }
 Region gate_oxide
 {
 material= SiO2
 }
 ...
 }

$Models
{

\end{verbatim}
1.2. Definition of physical and boundary regions in TiberCAD

Let's see now in more detail how to associate physical information to the regions of the device model and how to define the boundary regions, that is contacts or, in general, regions where some kind of boundary condition is to be applied.

When TiberCAD is run, it reads the mesh file which contains the finite element grid which meshes the geometrical description of the device or nanostructure, and which will be the basis of PDE discretization.

As we have seen before, to execute the proper simulations, TiberCAD needs some information about the physical and boundary regions associated with the mesh. A physical
region associates all the elements corresponding to an homogeneous part of the device (usually related to the same material or doping). In TiberCAD, these regions are referred to as mesh regions.

As for boundary regions, they are needed to specify boundary conditions (b.c.) for the solution of the PDEs of our simulation. By default, to all the external boundary of the device a Neumann b.c. is imposed, meaning null derivative of electric field and zero flux of current normal to the boundary. These are the usual b.c. applied in the simulation of electronic devices; in particular, these conditions are implicitly satisfied by using the finite element formulation. Usually, however, one needs to impose also specific b.c. to the device, relative, most often, to contacts of some kind (ohmic, schottky), but also heat and temperature b.c. or reference substrates for strain calculations. These regions, (constituted by surfaces, lines or points, respectively for 3D, 2D and 1D simulations) are called in TiberCAD boundary regions.

It is important to know that the information about the physical and boundary regions must be present in the mesh file before it is read by TiberCAD, and thus have to be produced by making use of the modeling/mesher software. As for now, TiberCAD supports the mesh output of the following software tools: GMSH v.2 and ISE-TCAD v.9.5.

1.2.1 Using ISE-TCAD

By means of the utility DEVISE of ISE-TCAD v.9.5, it is possible to design and mesh a device; after the meshing has been successfully performed, an output file is produced, with the extension .grd. This file contains the description of the mesh and also the list of the user defined material regions and contact regions. By reading this .grd file in TiberCAD, one can refer to the ISE TCAD material regions, simply with the user-defined name, which is present in the .grd file. This name should be unique in the whole device. In the same way, ISE TCAD Boundary regions (Contacts) can be referred to in TiberCAD by means of their user-defined name, present in the .grd output file, too.

1.2.2 Using GMSH

If GMSH program is used to model and mesh the device, a bit more care has to be taken. Here we introduce the procedure to be followed; in the following tutorials (Getting started... the subject will be considered in detail with a step-by-step description. See also the GMSH user manual (http://geuz.org/gmsh) for further details.

In the context of GMSH, it is possible to define several 1, 2 and 3D Physical Entities. These Physical Entities allow to associate one or more geometrical entities to a single numerical ID or, better, to a string label, so that several mesh regions and boundary
regions can be defined and referred to by TiberCAD. Here is a simple example of a script to generate a 1D geometrical model (*.geo) file in GMSH: (see also chapter 2)

Point(1) = {-25,0,0,0.5};
Point(2) = {0,0,0,0.002};
Point(3) = {25,0,0,0.5};
Line(1) = {1,2};
Line(2) = {2,3};

Physical Line("p_side") = {2};
Physical Line("n_side") = {1};
Physical Point("cathode") = {3};
Physical Point("anode") = {1};

Here, first the geometrical entities Points and Lines are defined.

In the definition of the geometrical Points, the three first expressions inside the braces on the right hand side give the three X, Y and Z coordinates of the point; the last expression (0.5 or 0.002 in this example) sets the characteristic mesh length at that point, that is the size of a mesh element, defined as the length of the segment for a line mesh element, the radius of the circumscribed circle for a triangle mesh element and the radius of the circumscribed sphere for a tetrahedron mesh element. Thus, the smaller is the value of the characteristic mesh length, the greater is the mesh density close to that point. The size of the mesh elements will then be computed in GMSH by linearly interpolating these characteristic lengths in the whole mesh.

In the definition of a geometrical Line, the two expressions inside the braces on the right hand side give the identification numbers of the start and end Points of the line.

Then, two physical regions are defined, each associated to one of the two geometrical entities: Physical Line(n_side) and Physical Line(p_side). The expression(s) inside the braces on the right hand side give, in general, the identification numbers of all the geometrical lines that need to be grouped inside the Physical Line.

In this way, these physical regions are made available for TiberCAD, and will be used to associate them to a TiberCAD region through the keyword Region, as follows:

Region n_side
{


Region p_side
It is also possible to group more than one physical region in a single Device Region, with the keyword `mesh_regions`, as follows:

Region `reg_1`
{
  mesh_regions = (region1, region2)
}

Region `reg_2`
{
  mesh_regions = (region3, region4)
}

Note that, in this case, `region1`, `region2`, `region3`, `region4` are the labels previously defined inside GMSH, while `reg_1` and `reg_2` are names chosen by user for his convenience.

Then, in the GMSH script, two `Physical Point` are defined, `anode` and `cathode`, and associated to the first and to the last point of our 1D device. These points are needed to impose some boundary conditions and in this way they are made available for TiberCAD, and will be used to associate each of them to a boundary condition region, through the keyword `BC_REGION`:

BC_Region
{
  BC_Region cathode
  {
    ...........
  }

  .................

BC_Region anode
{
  ...........

  ................
As before, it is possible group more boundary regions in a single BC\_Region, with the keyword BC\_reg\_nomb

BC\_Regions
{
  BC\_Region cathode
  {
    BC\_reg\_nomb = (contact1, contact2)
  }

  ......................

  ......................

Again, in this second case, cathode is a label chosen by user, while contact1 and contact2 are labels previously defined inside GMSH.

In 2D case, a set of Physical Surface will be defined to be used as mesh\_regions, while Physical Line is used for boundary regions.

Finally, in 3D case, Physical Volume is used to define mesh\_regions, while Physical Surface is used to define boundary regions.

1.3 Simulation environments

TIBER\_CAD allows to compute different physical models in different parts of a device or nanostructure by coupling in a general way different simulation environments. A simulation environment is composed by all the physical regions to which a particular model is assigned. A simulation environment is therefore defined by the mesh elements belonging to its physical regions and by the simulation model which has been associated to these regions. This association is made possible by the definition of TIBER\_CAD Regions and Clusters. Different simulation environments can have physical regions in common. In this way, each simulation is run on a subset of the device and can be possibly coupled (even self-consistently) with a simulation run on a different subset of the device corresponding to a simulation environment with a non-void intersection with the first one. The coupling of the two simulations is performed by means of appropriate Boundary Conditions (e.g. Current Density, Voltage, ...). In principle, the two simulation environments can refer to two simulations at different scale, e.g. atomistic tight-binding and macroscopic drift-diffusion. This allows an effective multi-scale simulation of the device to be studied.
Chapter 2

Getting started 1D

In this section we will see, step by step, how to use TiberCAD to simulate numerically a semiconductor device. As a very simple example we will refer to the Tutorial 0 (Si bulk) that you can find in the Tutorials directory.

Step 1: Modeling the device

As a first step, we have to model the device. To do so, you can use DEVISE module of ISE-TCAD 9.5 software package or GMSH program. Here we’ll see in details the procedure for GMSH. There are two possible ways to use GMSH:

1. Interactive, using the graphical interface
2. Using a script file.

In the following we’ll see how to write a basic GMSH script (bulk.geo); for any details please refer to GMSH manual GMSH (http://geuz.org/gmsh/).

In a GMSH script, several variables can be defined and given a value in this way:

L = 1;
d = 0.01;

these are valid GMSH variables: $L$ is just the length of the Si sample; $d$ is the value of a characteristic mesh length (see below).

- Definition of geometrical entities Points:

Point(1) = {0, 0, 0, d};
Point(2) = {L, 0, 0, d};
In the definition of a geometrical point, the three first expressions inside the braces on the right hand side give the three X, Y and Z coordinates of the point; the last expression \((d)\) sets the characteristic mesh length at that point, that is the size of a mesh element, defined as the length of the segment for a line mesh element, the radius of the circumscribed circle for a triangle mesh element and the radius of the circumscribed sphere for a tetrahedron mesh element.

Thus, the smaller is the value of \(d\), the greater is the mesh density close to that point. The size of the mesh elements will then be computed in GMSH by linearly interpolating these characteristic lengths in the whole mesh.

N.B.: In a 1D simulation it is assumed that the geometrical model is restricted to the \(x\) axis. Any other geometrical orientation could give unpredictable results.

- Definition of geometrical entity Line:

\[
\text{Line}(1) = \{1, 2\};
\]

The two expressions inside the braces on the right hand side give the identification numbers of the start and end points of the line.

- Definition of the physical entity Physical Line 1:

\[
\text{Physical Line}(1) = \{1\};
\]

The expression(s) inside the braces on the right hand side give the identification numbers of all the geometrical lines that need to be grouped inside the physical line. In this way, in general, physical regions are created which associate together geometrical regions, and then the related mesh elements, which share some common physical properties. It’s only these physical regions which can be referred to outside GMSH. In TiberCAD, this is done by associating one or more physical regions to a TiberCAD region through the keyword mesh_regions (see in the following).

- Definition of two physical entities Physical Point:

\[
\text{Physical Point}(1) = \{1\};
\text{Physical Point}(2) = \{2\};
\]

Beginning from GMSH v.2, it is possible, alternatively, to assign more convenient Physical Names to the Physical entities, instead of numerical IDs. Physical Names consist of strings enclosed between quotation marks. The syntax is the following:
Physical Line("bulk") = {1};

Physical Point("Anode") = {1};

N.B.: In general, in a n-Dimension \((nD)\) simulation, \((n-1)D\) physical regions (points in 1D, lines in 2D, surfaces in 3D) are used by TiberCAD to impose the required boundary conditions. Each \((n-1)D\) physical region defined in this way in GMSH will be associated in TiberCAD to a boundary condition region, through the keyword \textbf{BC\_reg\_numb}. Thus, in this case, Physical points 1 and 2 will be associated respectively to two BC regions (see in the following).

**Step 2: Meshing the device**

The \textit{.geo} script file with the geometrical description can be run in GMSH, to display the modelled device and to mesh it through the GMSH graphical interface. Alternatively, a non-interactive mode is also available in GMSH, without graphical user interface. For example, to mesh this 1D tutorial in non-interactive mode, just type:

```bash
gmsh bulk.geo -1 -o bulk.msh
```

where \textit{bulk.geo} is the geometrical description of the device with GMSH syntax; \(-1\) means 1D mesh generation;

some command line options are:

\(-1\), \(-2\), \(-3\) to perform 1D, 2D or 3D mesh generation,

\(-o\) \textit{mesh\_file.msh} to specify the name of the mesh file to be generated

In this way, a \textit{.msh} has been generated and is ready to be read in TiberCAD.

**Step 3: TiberCAD Input file**

Now we have to write down the TiberCAD input file (see \textit{bulk.tib} in the Tutorials).

**1 - Definition of Device Regions**

First, we have to list all the TiberCAD Regions present in our device: a TiberCAD \textbf{Region} is usually a somehow physically homogeneous region of the device or the nanosstructure we are going to model, featuring the same material and possibly the same doping.

```tiber
$Device
{
Region bulk
```
In this example, the TiberCAD Region bulk is made of Silicon and n-doped with a concentration $10^{16}\,\text{cm}^{-3}$.

Through the keyword `mesh_regions`, one or more of the physical regions (Physical Lines in 1D, Physical Surfaces in 2D, Physical Volumes in 3D) previously defined in the GMSH mesh can be associated to the present TiberCAD Region.

With `mesh_regions = 1`, we associate the Physical Line 1, defined in the Step 1, to the TiberCAD Region bulk.

2 - Definition of Simulation

Now we define the Simulation `driftdiffusion_1`: it belongs to the class `driftdiffusion` Models

```{model driftdiffusion
{options
{simulation_name = driftdiffusion_1
physical_regions = all
}
```

The TiberCAD simulation `driftdiffusion_1`, belonging to the model `driftdiffusion`, will be applied to the whole device structure (`physical_regions = all`).

3 - Definition of Boundary Conditions

The anode and cathode contacts of our 1D Si sample are defined as Boundary conditions regions (`BC_Region anode, BC_Region cathode`) in the following way:

```{BC_Region anode
{BC_reg_numb = 1
```
Both contacts are defined as *ohmic*, cathode is assigned a fixed \( \text{voltage} = 0.0 \), while anode voltage is given by the value of the variable \( Vb \) \( (\text{voltage} = @Vb) \).

Through the keyword `BC_reg_numb`, one or more of the \((n-1)\)-Dimension physical regions (Physical Points in 1D, Physical Lines in 2D, Physical Surfaces in 3D) previously defined in the GMSH mesh can be associated to the present TiberCAD BC Region. With `BC_reg_numb = 1`, we associate the Physical Point 1, defined in the Step 1, to the TiberCAD BC Region *anode*; with `BC_reg_numb = 2`, we associate the Physical Point 2, defined in the Step 1, to the TiberCAD BC Region *cathode*.

Alternatively, one can make use of the physical names associated to the physical regions in the meshing tool. In this case, we simply associate the \((n-1)\)D physical region, respectively “anode” and “cathode”, by means of the TiberCAD BC Region name:

```plaintext
BC_Region anode
{
    type = ohmic
    voltage = @Vb
}

BC_Region cathode
{
    type = ohmic
    voltage = 0.0
}
```

Note that, in this case, the TiberCAD BC Region name needs to be identical to one of the physical names defined during the modeling of the device with GMSH.
4 - Definition of Simulation parameters

The variable \( V_b \) is specified in the \textit{sweep} block, in the \textbf{Solver} section

\begin{verbatim}
  sweep 
  { 
    simulation = driftdiffusion_1 
    variable = Vb 
    start = 0.0 
    stop = 1 
    steps = 10 
  }
\end{verbatim}

In this way, the simulation \textit{driftdiffusion\_1} is performed for 10 (\textit{steps = 10}) values of the anode voltage (\textit{variable = Vb}), between 0 and 1.

5 - Definition of Execution parameters

In the \textbf{Simulation} section, we decide \textit{which} simulations to perform and in which \textit{order}; we set \textit{solve = sweep}, to execute the \textit{sweep} which run \textit{driftdiffusion\_1 simulation} for the specified loop.

\begin{verbatim}
  $Simulation 
  { 
    #searchpath = . 
    meshfile = bulk.msh 
    dimension = 1 
    temperature = 300 
    solve = sweep 
    resultpath = output 
    output_format = grace 
    plot = (Ec, Ev, ContactCurrents) 
  }
\end{verbatim}

Output files with conduction and valence band profiles (\textit{plot = Ec,Ev..}) and all the calculated values of the current at the contacts (\textit{ContactCurrents}) (the IV characteristic) are generated.

\section*{Step 4: Run TiberCAD}

Now we can run TiberCAD:
tibercad bulk.tib

The generated Output files are:
driftdiffusion_materials.dat: material (mesh) regions, in this case just region 1
driftdiffusion_nodal.dat: nodal quantities (here conduction and valence band)
sweep_driftdiffusion_Vb.dat : integrated current at the two contacts for each sweep step.
Chapter 3

Getting started 2D

In this second example we will refer to the Tutorial 4 (Si n-Mosfet) that you can find in the Tutorials directory.

Step 1: Modeling the device

Again, as a first step, we have to model the device.

We’ll see in some details how to design and mesh a mosfet device with GMSH.

• In the GMSH script mosfet.geo, several variables are defined and given a value in this way:

    lsub=0.03;
lacc=0.002;
lct=0.0005;
lg=0.0015;
lh=0.01;
lc=0.0005;

    these variables are used in the script to assign proper values to the mesh characteristic length of the defined Points

    Lg_2 = 0.0375;
d = 0.01;
Ls = 0.1;
h = 0.25;
b = 0.0025;
o = 0.005;
\( xd = Lg_2 + d; \)
\( xd2 = Lg_2 + d / 2; \)
\( xmax = xd + Ls - d; \)

These other convenient variables are used to parametrize the most relevant geometrical features, such as channel length, oxide thickness, and so on.

- Geometrical **Points** and **Lines** are defined to design the device structure; the fourth parameter in **Point** assignment is the characteristic length associated to that point: this is an essential feature to control the mesh density and refine it where necessary (usually in the channel region).

**N.B.**: In a 2D simulation it is assumed that the geometrical model is restricted to the \( xy \)-plane \( (z = 0) \). Any other geometrical orientation could give unpredictable results.

Point(1) = \{0, -h, 0, lsub\};
Point(2) = \{0, 0, 0, l_c\};
Point(3) = \{xmax,-h,0.0,lsub\};
Point(4) = \{-xmax,-h,0.0,lsub\};
Point(5) = \{xmax,0,0.0,lh\};
Point(6) = \{-xmax,0,0.0,lh\};

..................

Line(1) = \{4,1\};
Line(2) = \{3,13\};
Line(6) = \{4,14\};
Line(7) = \{10,9\};
Line(8) = \{12,2\};
Line(9) = \{8,7\};
Line(10) = \{11,8\};
Line(11) = \{9,12\};
Line(13) = \{7,6\};

..................

- Definition of a surface: first a **line loop** is composed, listing all the lines constituting the boundary of the surface; then this line loop is assigned to a **Plane Surface** object (this procedure can be alternatively performed through the graphical interface).

Line Loop(40) = \{28,2,-34,33,8,29,-31,-30,-6,1\};
Plane Surface(41) = \{40\};

..................
• Definition of the **Physical surfaces**: each of them is composed by one or more geometrical **Plane Surface**. For example, **Physical surface 2** comprises the two separated contact regions, while **Physical surface 3** corresponds to the oxide region.

The **Physical surfaces** are the 2D Physical regions of the mesh and will be assigned to the related TiberCAD regions through the keyword `mesh_regions` (see Step )

```plaintext
Physical Surface(1) = {41}; // n-Si
Physical Surface(2) = {44,47}; // n+-Si
Physical Surface(3) = {46}; // SiO2
```

• Definition of the **Physical Lines**: In this 2D simulation, 1D physical regions are used to carry information about boundary condition regions. In other word, each **Physical Line** corresponds to a boundary condition (a contact in the case of a drift-diffusion calculation): thus Physical Line 1 refers to source contact, P.L. 2 to gate contact, P.L. 3 to drain contact. The numerical identifications of these **Physical Lines** will be assigned to TiberCAD BC regions by means of the `BC_reg numb` instruction.

```plaintext
Physical Line(1) = {13}; // source
Physical Line(2) = {39,38}; // gate
Physical Line(3) = {19}; // drain
```

In fig. 3.1 the obtained geometrical model is shown.

**Step 2: Meshing the device**

The .geo script file with the geometrical description can be run in GMSH, to display the modelled device and to mesh it through the GMSH graphical interface (see fig. 3.2). Alternatively, a non-interactive mode is also available in GMSH, without graphical user interface. For example, to mesh this 2D tutorial in non-interactive mode, just type:

```
gmsh mosfet.geo -2 -o mosfet.msh
```

**Step 3: TiberCAD Input file**

Now we have to write down the TiberCAD input file (see mosfet.tib in the Tutorials).
Figure 3.1: Geometrical structure as defined by GMSH modeller

Figure 3.2: 2D Mesh for the mosfet device obtained with GMSH
1 - Definition of Device Regions

Three TiberCAD regions are defined: to each of them, one mesh_region is associated, that is the Physical Surfaces 1, 2 and 3 defined in Step 1. However, in general more than one mesh_region can be associate to a single TiberCAD region, if this is convenient.

Region substrate
{
  mesh_regions = 1
  material = Si
  doping = 1e18 doping_type = acceptor
}

Region contact
{
  mesh_regions = 2
  material = Si
  doping = 5e19 doping_type = donor
}

Region oxide
{
  mesh_regions = 3
  material = Si02
}

2 - Definition of Simulation

Now we define the Simulation dd: it belongs to the class driftdiffusion

    model driftdiffusion
    {

      options
      {
        simulation_name = dd
        physical_regions = all
      }
    }
We declare two **driftdiffusion physical models**: the first defines a *srh recombination* model (see 6.3.1); the second defines a *field-dependent mobility* model for electrons which implements a *doping dependence* for the **low-field mobility** (see 6.3.3).

```plaintext
class physical_model recombination
{
    model = srh
}
class physical_model electron_mobility
{
    model = field_dependent
    low_field_model = doping_dependent
}
```

### 3 - Definition of Boundary Conditions

The source, drain and gate contacts of the Mosfet device are defined as **Boundary conditions regions** (*BCRegion source*, *BCRegion drain*, *BCRegion gate*) in the following way:

```plaintext
class BCRegion gate
{
    BC_reg_numb = 2
    type = schottky
    barrier_height = 3.0
    voltage = @Vg[0.0]
}
class BCRegion source
{
    BC_reg_numb = 1
    type = ohmic
```
voltage = 0.0

BC Region drain
{
    BC_reg_numb = 3
    type = ohmic
    voltage = @Vd[0.5]
}

To each of the BC regions, one BC_reg_numb is assigned, that is one of the Physical Lines 1, 2, 3 defined in Step 1, which represent the contact regions.

Note that, while source and drain are defined as type= ohmic, gate BC region is defined as type = schottky; barrier_height = 3.0 specifies the metal/oxide interface barrier and depends on the contact metal workfunction.

Drain voltage is defined as @Vd[0.5] and gate voltage as @Vg[0.0]. This specifies that the value of the voltage will be determined at each moment of the simulation, by the value of the two variables Vd and Vg, which will be assigned in the sweep definition.

4 - Definition of Simulation parameters

Two sweeps are requested for this simulation, that is an external loop on Vg (the gate voltage) and an internal loop on Vd (the drain voltage) for each value of Vg; in this way, the IV drain characteristics for a series of gate biases are obtained in output.

sweep_1
{
    simulation = dd
    variable = Vd
    start = 0.0
    stop = 2.0 #0.1
    steps = 200 #200 #1
    # plot_data = true
}

sweep_2
{
    variable = Vg
start = -0.1  
stop = 0.5  
steps = 6  
simulation = sweep_1  
#simulation = driftdiffusion

\section*{5 - Definition of Execution parameters}

In the \texttt{Simulation} section, we decide the simulation dimension (\texttt{dimension = 2}), then \textit{which} simulations to perform and in which \textit{order}; we set \texttt{solve = sweep_2}, to execute the external gate voltage sweep \texttt{sweep_2} which in its turn call the sweep \texttt{sweep_1} where drain current is calculated for all the chosen drain voltage steps by running \texttt{dd simulation}.

$\$Simulation$
{  
meshfile = mosfet.msh  
dimension = 2  
temperature = 300  
solve = sweep_2  
resultpath = output_IV_char  
output_format = vtk  
plot = (Ec, Ev, QFermi_e, QFermi_h, eDensity, hDensity, eCurrent, hCurrent, NetRecombination, EField, ElPotential, ContactCurrents)
}$

Output files with conduction and valence band profiles, quasi-fermi levels, electron and hole density, recombination, electric field and potential (\texttt{plot = Ec,Ev,.....}) will be generated, together (\texttt{ContactCurrents}) with a file with all the calculated values of the drain current at the contacts for each gate bias step (the IV characteristics).

\section*{Step 4: Run TiberCAD}

Now we can run TiberCAD:  
\begin{verbatim}
tibercad mosfet.tib
\end{verbatim}

The generated \texttt{Output} files are:
driftdiffusion_materials.vtk: information about the material regions of the device.

driftdiffusion_nodal.vtk output for the nodal quantities which have been calculated, e.g. conduction and valence bands, (quasi)fermi levels, electron and hole density and mobility.

driftdiffusion_elemental.vtk output for the elemental quantities (e.g. electric field, current density).

sweep_2.driftdiffusion_Vg.0.000_Vd.dat and similar for all the $V_g$ steps: drain current characteristics for each $V_g$ bias.
Chapter 4

Input for TiberCAD

Input for TiberCAD is composed by an input file e.g. "input.tib" and a mesh file generated by a mesher software: as for now, mesh files from GMSH (*.msh, v.1 and v.2.0) and from ISE-TCAD (*.grd) are supported.

Be sure that the material files are in the correct directory (as specified in 4.7).

To run the program, type: tibercad input_file_name

4.1 Description of Input file structure

A valid input file for TiberCAD is a text file with the structure described in the following.

In the whole input file, everything following a '#' is considered as a comment and is disregarded; blank lines can be present anywhere and are disregarded too.

Input file is composed by several sections: each section begins with a section-name preceded by "$" (e.g. $Physics).

A section is enclosed between "{" and "}" brackets and is possibly composed (depending on the section) by a variable number of blocks enclosed between "{" and "}" brackets.

Each block can be possibly composed by one or more blocks, each preceded by a block-name.

The elementary block (parameters-block) is a block which contain zero or any number of parameter assignments in the form:

"tagname = tagvalue",

where

- "tagname" is a string
- "tagvalue" is a single numerical or string item or a list of items between "(" and ")" parenthesis and separated by commas. e.g. (cathode, anode)
Format is free for the parameter assignements, provided that they are separated by spaces. Everything which follows a `#` is considered as a comment and is disregarded. For example:

```plaintext
driftdiffusion
{
  coupling = poisson
  nonlin_max_it = 70
  nonlin_rel_tol = 1e-10

  ls_max_step = 2
  ksp_type = bcgs
}
```

Here and in the whole input file a string item can include a combination of characters, special characters and numbers, but not spaces; if a space is found, the string item is taken as terminated.

The input file is composed by the following sections:

- Device, Scale, Models, Physics, Solver, Simulation

which will be described in the following.

## 4.2 Device section

```plaintext
$Device
{
  Region buffer
  {
    ..........
  }
  Region barrier_1
  {
    ............
  }
  .................
}
```

In "Device" section, two kinds of block can be present: the Region block and the Cluster block.
The Region blocks contain the description of the device in continuous media approach; the Cluster blocks define each a group of regions (mesh_regions) even with different physical properties, but to be treated together somewhere in the simulation (e.g. quantum calculation). In this way it is possible to refer to the set of these regions simply by the Cluster name.

Each Region block must be preceded by the keyword "Region", followed by the (single-word) name of the TiberCAD Region. The name of the TiberCAD Region can coincide with the name of a mesh region, as defined during the modeling of the device; in this case, if the keyword mesh_regions is absent, the TiberCAD Region will be associated to the mesh region identified by the name assigned to the TiberCAD Region. Otherwise, the TiberCAD Region will be associated to the mesh regions specified by the keyword mesh_regions.

Region QWell
{
    mesh_regions = (4,5)
    # mesh_regions = 4
    structure = wz
    y-growth-direction = (1,0,-1,0)
    z-growth-direction = (-1,2,-1,0)
    x-growth-direction = (0,0,0,1)
    material = GaN
    doping = 1e17 doping_type = donor doping_level = 0.025
}

Here are the description of the available keywords for a Region block.

material (mandatory): name of the material associated to the present region, e.g Si; it may be a ternary alloy, e.g AlGaAs, in this case keyword x described in the following has to be present.

x: alloy concentration, expressed as the molar fraction of the first component of the alloy; e.g. to express an alloy $Al_xGa_{1-x}As$ with molar fraction $x = 0.2$, that is $Al_{0.2}Ga_{0.8}As$, we select AlGaAs for the keyword material, and 0.2 for the keyword x, thus we write $x = 0.2$.

mesh_regions : (a list of) region ID(s) or physical name(s) as specified in the meshing program.
structure : crystal structure (wz = wurtzite, zb = zincblend)
x-growth-direction, y-growth-direction, z-growth-direction: Bravais vectors with Miller indexes for wurtzite crystal (4 element vectors) or zincblende crystal (3 element vectors).
doping : doping concentration [cm$^{-3}$]
doping_type : donor or acceptor
**doping_level**: energy level of the dopant [eV]

Each **Cluster** block must be preceded by the keyword "**Cluster**", followed by the (single-word) name of the **Cluster**.

```plaintext
Cluster Quantum_1
{
    mesh_regions = (3,4,5)
}
```

**mesh_regions** (mandatory): list of physical regions (region IDs or physical names) or TiberCAD region names, as specified in the meshing program, to be grouped in the cluster.

**Regions** and **Clusters** represent the macroscopical description of the device or structure to be be simulated in TiberCAD. In the rest of the input file, the physical regions associated to **Models** or **Atomistic** descriptions will be indicated by means of the TiberCAD **Region** and **Cluster** names.

### 4.3 Scale section

The section "**Scale**" is dedicated to the optional definition of Non-Continuous Media regions for the device: these regions will be described and studied at a different scale (e.g. atomistic, circuit level lumped model, etc.) As for now, just the atomistic description is implemented. **Atomistic** blocks, if present, specify a possible atomistic description associated to one or to a group of physical regions described by **Region** blocks. So, for each **Atomistic** block defined in Input file, an atomic structure description will be generated and used to solve a simulation problem with an atomistic approach. The association to the physical (macroscopic) regions of the device allows the implementation of multi-scale calculations.

Each **Atomistic** block must be preceded by the keyword "**Atomistic**", followed by the (single-word) name of the atomistic region.

```plaintext
Atomistic TB_1
{
    physical_regions = (barrier_1, qwell, barrier_2)
    # physical regions to be described
    # with atomistic model.
}
```
4.4 MODELS SECTION

Here are the description of the available keywords for an Atomistic block.

*physical_regions* (mandatory): list of the physical regions (*TiberCAD Regions* or *Clusters*) of the device associated to an atomistic description. *all* (default) is used to specify all the physical regions.

*path* (optional): path for importing an atomistic structure from an external file. *xyz* and *gen* formats are supported, and are automatically recognized by file extension. Each of the atom positions is imported as is, so the atom coordinates must be consistent with the geometry of the device.

If no path is specified, the *TiberCAD Atomistic Generator* builds the atomistic structure; it is constructed as a bulk crystal structure, covering with proper atomic species the physical regions and taking into account the dimension of the problem (up to now 1D structures are supported).

Atomistic Generator options, to be put in the Atomistic section, are described in the following.

*reference_region* (mandatory): the Atomistic Generator can only build pseudomorphic heterostructures. A reference region must be defined to specify from which region (*TiberCAD Regions*) to get structure parameters such as lattice constants, which depend on the material defined in the reference region.

*passivation* (optional): *no* is default option. If set to *no*, no passivation is performed. If *yes* is specified, a hydrogenation of the structure is performed, taking into account the structure periodicity. Up to now, hydrogenation is supported for Silicon structures.

*preserve* (optional): Default is *none*. In some cases it is requested to build a structure in which the atom basis or the conventional cell has been preserved, regardless to mesh geometry. If *none* is specified, no conservation is performed and only atoms strictly belonging to geometrical regions are put in the atomic structure. If *lattice* is specified, atom basis is preserved (e.g. to preserve anion/cation couples). If *conventional* is specified, conventional cell is preserved.

*y_lenght* (optional): Atomistic Generator builds the minimum periodical structure along *y* and *z* directions. If *y_lenght* is specified, the structure will be at least *y_lenght* sized along *y_growth_direction*. Exact length is internally defined in order to keep structure periodicity.

*z_lenght* (optional): same as above, for the *z* direction.

4.4 Models section

```bash
$Models
{
    model driftdiffusion
    {
```
In "Models" section, one or more model-blocks must be present: each model-block must be preceded by the keyword "model", followed by the (single-word) model name. This must be the name of one of the TIBERCAD simulation models.

Here are the simulation models implemented until now:

- **driftdiffusion**: Poisson-driftdiffusion transport of electrons and holes
- **thermal**: Heat balance simulation
- **excitontransport**: Exciton transport model
- **macrostrain**: Calculation of Elastic deformations in heterostructures
- **efaschroedinger**: Envelop Function Approximation (EFA) solution of single-particle Schrödinger equation for electrons and holes
- **quantumdensity**: Calculation of quantum density of electrons and holes.
- **quantumdispersion**: Dispersion of quantized states in \( k \) space
- **opticskp**: Optical properties (optical \( kp \) matrix elements)
- **opticalspectrum**: Emission spectrum (with \( k \)-space integration)
4.4. MODELS SECTION

For a complete description of these simulation models, see the next chapters. Each model-block can contain some optional blocks, to be written in the following order:

- one "options" block, preceded by the keyword "options". This block can contain general options for the present model.

- one or more physical_model blocks: each physical_model block must be preceded by the keyword "physical_model", followed by the (single-word) name of the physical model. Each physical_model block can contain parameters relevant to a specific model of a physical property or quantity related to the present model.

- one or more Boundary Condition regions blocks (BC_regions-block). The BC-regions-block must be preceded by the keyword "BC_Regions" and it is composed by one or more parameters-blocks, each preceded by the keyword "BC_Reregion" followed by the (single-word) name of the boundary condition region. This parameters-block can contain the possible description of the boundary region.

These optional blocks must be strictly in this order: first the options, then the physical_model, and finally the BC_regions-blocks. A detailed description of the possible parameters for these blocks follows.

4.4.1 options block

```plaintext
options
{
  simulation_name = dd1
  #physical_regions = all
  physical_regions = (channel_1, channel_2)
}
```

- **simulation_name**: user-defined name of the particular instance of the simulation model defined for this block. More than one simulation (with different name and properties) can be defined, in separated model blocks, which refer to a same TiberCAD simulation model. If simulation_name is not assigned, by default the TiberCAD model name is taken as current simulation_name.

- **physical_regions**: (list of) physical region(s) to which the present simulation model will be applied. Physical region(s) are the TiberCAD regions or clusters as defined in Device section.

  Default value is "all" (all physical regions of the device). In a list, the names must be separated by comma and enclosed between ‘(‘ and ‘)’ parenthesis
CHAPTER 4. INPUT FOR TIBERCAD

4.4.2 physical_model block

physical_model recombination
{
    model = SRH
}

The following options can be applied to any physical_model:

name a user defined name for the model for unique identification

restrict_to_region a single region name or a list of regions where the model should be used. This allows to use different implementation of the same type of model in different regions.

4.4.3 BC_region block

BCRegion anode
{
    BC_reg_numb = 2
    type = ohmic
    #voltage = 0.0
    voltage = @Vb[1.5]
}

BC_region: name of the present boundary region; it can be the name of a boundary (physical) region specified in the meshing program (GMSH or ISE-TCAD).

BC_reg_numb: BC region ID(s) as specified in the meshing program (GMSH). If this keyword is not present, it is assumed that the mesh region associated to this TiberCAD BC region is given by the name assigned to BC_region.

type: type of boundary condition: ohmic, schottky,... , substrate (for strain calculations).

voltage: value of voltage [V] applied to the present BC region (for ohmic and schottky BCs); it can be the value of a sweep variable 'Vb', indicated with @Vb. A possible default value can be indicated in parenthesis: @Vb[1.5]

zero_grad_fermi_h, zero_grad_fermi_e: if true set Neumann b.c. to the fermi level in the b.c. region.

If type is substrate (for strain calculations):

material : name of material in the substrate region.
structure : crystal structure ( wz = wurtzite, zb = zincblend)

x-growth-direction, y-growth-direction, z-growth-direction: Bravais vectors with Miller indexes for wurtzite.
In this section one may choose and define the setting parameters for the numerical solvers to be applied to the specified simulations: the section is organized in blocks, each one preceded by a block-name. This block-name may be

1. the name of one of the user-defined simulations: in this case, the solver parameters defined in each block will refer only to that particular simulation.

2. the name of a TiberCAD Model: only in this case, the settings will be applied to all the simulations belonging to that Model

For details on the available parameters for each Model, see the relevant chapter in this Guide.
In addition, two special (optional) blocks may be present: the **Sweep** block and the **Selfconsistent** block

- **Sweep** block, preceded by the keyword ”**Sweep**”. This block may contain one or more subblocks, each one defining a set of calculations applied to a boundary region (e.g. a set of bias values to be assigned to a drain contact of a MOSFET for the calculation of an output drain IV characteristic), in this Guide referred to as *sweep* calculation.

Each *sweep* definition must be preceded by its user-defined name (e.g. *sweep_1*). (see Listing 1)

In the case of a single sweep subblock, for backward compatibility, it is also allowed to define the *sweep* feature by means of the keyword *sweep* (lower case), in the following way:

```
sweep
{
    simulation = driftdiffusion
    variable = Vb
    start = 0.0
    stop = 4.0
    steps = 80
    plot_data = true
    plotvariable = current
}
```

The following keywords are defined for this feature:

- **variable**: name of the variable to which the *sweep* is applied: its value is assigned to a quantity (e.g. voltage) in a BC Region section to perform the *sweep* calculation (see 4.4.3).

- **start, stop, steps**: sweep starts from *start* value, is repeated *steps* times and stops in *stop*

- **simulation**: name of the simulation (model) associated to the sweep calculation; it may be the name of another sweep defined in the same block.

- **plotvariable** (obsolete): specify the integrated quantity to be calculated during the sweep and that will be shown in the output file *sweep_modelname_sweepvariable.dat*, eg. *sweep_driftdiffusion_Vb.dat* for a sweep of current calculation on the variable *Vb* (typically a contact voltage).
Sweep
{

sweep_1
{
    simulation = driftdiffusion
    variable = Vd
    start = 0.0
    stop = 2.0 #0.1
    steps = 20 #50

    # plot_data = true
}

sweep_2
{
    variable = Vg
    start = -0.1
    stop = 1.0 #0.5
    steps = 11 # 6
    simulation = sweep_1
    #simulation = driftdiffusion

    plot_data = true
}
}

Listing 1: Example of Sweep section
**plot_data**: default is false; if it is set to true, then output data will be written for each step of the sweep calculation, otherwise just the results for the final step will be present in the output.

Once a *sweep* calculation has been defined, it is treated as a special case of simulation and may be executed as an usual *simulation*: by adding it in the *solve* list, e.g. *solve = sweep_drain* (see 4.7).

- **Selfconsistent** block, preceded by the keyword ”**Selfconsistent**”. This block may contain one or more subblocks, each one defining a self-consistent calculation based on two different simulation models (e.g. driftdiffusion and excitontransport). The definition of a *selfconsistent* calculation must be preceded by its user defined name (e.g. *converse_piezo*):

```plaintext
Selfconsistent
{

    converse_piezo
    {
        flavour = relaxation
        simulations = (driftdiffusion, strain)
    }

    dd_excitons
    {
        flavour = relaxation
        simulations = (driftdiffusion, exciton)
    }

}
```

**Listing 2**: Example of **Selfconsistent** section

The following keywords are defined for this feature:

**simulations**: the list of simulations to be performed self-consistently.

**flavour**: specifies broyden or relaxation approach
Once a selfconsistent calculation has been defined, it may be executed as an usual simulation: by adding it in the solve list, e.g. solve = dd_excitons (see 4.7), or even in the sweep section, with, for example, simulation = converse_piezo. In both cases, the specified simulations will be executed in a self consistent way.

In the case of a single self-consistent calculation block, for backward compatibility, it is also possible to define the self-consistent feature by means of the keyword selfconsistent (lower case), in the following way:

selfconsistent
{
    flavour = relaxation
    simulations = (driftdiffusion, excitons)
}

4.6 Physics section

In this section several physical parameters can be entered, in addition to or overwriting the material parameters present in the material files. The section is organized in blocks, each one preceded by a block-name.

This block-name may be

1. the name of one of the user-defined simulations: in this case, the physical parameters defined in each block will refer only to that particular simulation.

2. the name of a TIBERCADModel: only in this case, the settings will be applied to ALL the simulations belonging to that Model

For details on the available parameters for each Model, see the relevant chapter in this Guide.

For example in this case:

strain_simulation is used to specify the simulation that provides strain data, in case of strained systems (see 6.4).

4.7 Simulation section

In this section one can specify several general parameters and settings for the actual calculation to be run, such as the mesh file to be used, the dimension of simulation, the process-flow of simulation, etc.

searchpath: path for material files
driftdiffusion
{

    strain_simulation = strain

}

---

meshfile: name of mesh file. N.B.: the extension is mandatory! (.grd for ISE-TCAD, .msh for GMSH mesh file v.1 and v.2.0)
mesh_units: units of measurements used in the meshing (relative to meters): e.g., 10^{-6} for \( \mu \text{m} \)
dimension: dimension of simulation (1,2,3)
temperature: temperature of the system [K]
solve: list of simulations to be executed, in the order of execution; if the list contains "sweep", a sweep is performed as specified in sweep block in the Solver section.
solve = (strain,driftdiffusion, quantum_electrons, quantum_holes)

resultpath: path for output directory
output_format: format of the output data: gmv for GMV, ise for Tecplot, grace for xmgr (ascii data column type), vtk for Paraview.
plot: list of output variables which are calculated and available in output files. See the corresponding chapters for the available output variables for each model.

4.8 Output description

At the end of the execution, the program will write the results of the simulation in the directory specified by resultpath, with the format specified by output_format. The output variables are specified in the list plot.

TiberCAD output is divided in three classes: nodal, elemental and integrated quantities.

Nodal quantities are all the quantities associated with the nodes of the mesh, such as Fermi level, electron and hole density, conduction and valence band, etc. The output values for these quantities are reported in the files modelname_nodal.ext, where modelname is the simulation model used for the calculations and ext is the extension of the chosen file format.
4.9. EXAMPLE OF INPUT FILE

In the case a sweep calculation is performed and the `plot_data` keyword is set to `true`, the output files are of the kind `modelname_nodal_sweepvariable_step.ext`, where `sweepvariable` is the variable with respect to which the sweep is performed (e.g. gate voltage) and `step` is the value of this variable at that step; e.g. `driftdiffusion_nodal_Vb_0.000.dat` for the result at the step $V_b = 0.0$.

**Elemental** quantities are all the quantities associated with the elements of the mesh, such as current density. The output values for these quantities are reported in the files `modelname_elemental.ext`.

In the case a sweep calculation is performed and the `plot_data` keyword is set to `true`, the output files are of the kind `modelname_elemental_sweepvariable_step.ext`. e.g. `driftdiffusion_elemental_Vb_1.150.dat`

**Integrated** quantities are the quantities which are not associated to the mesh but are obtained by an integration on real or reciprocal space, for example current at the contacts of a diode or quantized energy levels in a quantum well. These **Integrated** quantities are displayed in separated files, with the format `simname.ext`, e.g. `quantum_electrons.dat`, where `simname` is the name of the model (simulation) associated to the results. If a sweep is performed, the output file gets the format `sweep_simname_varname.ext`, where `varname` is the variable with respect to which the sweep is performed, for example `sweep_driftdiffusion_Vb.dat`. Inside the file, output values for all the steps of calculation are shown.

Finally, a last class of output files is the **Materials** output. These files contain the information about the physical regions of the device; for each class of simulation, a different material file is produced, containing all and only the mesh regions associated to that simulation model. The file has the format `simulationname_materials.ext`, e.g. `driftdiffusion_materials.dat`

4.9 Example of Input file

Here is an example of the input file template:

```plaintext

# Description of the device physical regions
$Device
{

  # Syntax:
  #
  # Region "Tiber_region"

```


Region buffer
{
    mesh_regions = 1
    structure = wz
    y-growth-direction = (1,0,-1,0)
    z-growth-direction = (-1,2,-1,0)
    x-growth-direction = (0,0,0,1)
    material = GaN
    doping = 1e15
    doping_type = donor
    #doping_level = 0.025
}

Region barrier_1
{
    mesh_regions = (2,3)
    structure = wz
    y-growth-direction = (1,0,-1,0)
    z-growth-direction = (-1,2,-1,0)
    x-growth-direction = (0,0,0,1)
    material = AlInN
    x = 0.80 #
    doping = 1e15
    doping_type = donor
    #doping_level = 0.025
}

Region QWell
{
    mesh_regions = 4
4.9. EXAMPLE OF INPUT FILE

structure = wz
y-growth-direction = (1,0,-1,0)
z-growth-direction = (-1,2,-1,0)
x-growth-direction = (0,0,0,1)
material = GaN
doping = 1e15 #
doping_type = donor #
# doping_level = 0.025

}

Region barrier_2
{
  mesh_regions = (5,6)
  structure = wz
  y-growth-direction = (1,0,-1,0)
z-growth-direction = (-1,2,-1,0)
x-growth-direction = (0,0,0,1)
material = AlInN
  x = 0.80 #
doping = 1e15 #
doping_type = donor
# doping_level = 0.025

}

# Cluster = group of mesh_regions with DIFFERENT material (in general)

# Syntax:
# # Cluster "Tiber_cluster"
# mesh_regions = "list gmsh region ID/names" | "list ISE_TCAD region names"
# "Tiber_cluster" to be used in Models section

Cluster Quantum_1
{
  mesh_regions = (3,4,5)
CHAPTER 4. INPUT FOR TIBERCAD

#Definition of the description scale (only for not-Continuous Media regions )
# Syntax:
#
# "level" "scale_cluster"
# "level" = "Atomistic | ..."
# physical_regions = "list (Tiber_region | Tiber_cluster) "
#
# ******** $Scale section is optional ********
#
$Scale
{

  Atomistic TB_1
  {
    physical_regions = (barrier_1 , QWell , barrier_2 )
  }

  Atomistic TB_2
  {
    physical_regions = ............
  }
}
# Definition of Simulation Models and associated Boundary Conditions

$Models
{

model driftdiffusion
{

options
{
    simulation_name = dd1

    physical_regions = all
}

physical_model recombination
{
    model = srh
}

physical_model recombination
{
    model = direct
    C = 1.1e-8
}

BC_Regions
{
    BC_Region cathode
    {
        BC_reg numb = 1
        type = ohmic
        voltage = 0.0
    }
}
BCRegion anode
{
  BC_reg_numb = 2
  type = ohmic

  voltage = 0.0
}

model macrostrain
{
  options
  {
    simulation_name = strain
    physical_regions = all
  }

  BC_Regions
  {
    BCRegion substr
    {
      BC_reg_numb = 1
      type = substrate
      material = GaN
      structure = wz
      y-growth-direction = (1,0,-1,0)
      z-growth-direction = (-1,2,-1,0)
      x-growth-direction = (0,0,0,1)
    }
  }
}
model efaschroedinger

{

    options
    {
        simulation_name = quantum_electrons

        # Syntax:
        #
        # physical_regions = "list (Tiber_region | Tiber_cluster)"

        physical_regions = Quantum_1

    }

}

model efaschroedinger

{

    options
    {
        simulation_name = quantum_holes
        physical_regions = Quantum_1

    }

}

# Definition of Model-dependent Solver parameters
$Solver
driftdiffusion
{
  coupling = poisson
  ksp_type = bcgsl
  nonlin_abs_tol = 1e-10
  nonlin_step_tol = 1e-2
  #nonlin_rel_tol = 1e-12
  lin_rel_tol = 1e-6
  nonlin_max_it = 30
  #local_density_scaling = true
  #ls_type = none
  discretization = fem
  ls_max_step = 1
  #pc_type = lu
  pc_type = composite
  integration_order = 2
  #relaxation_factor = 0.5
}

macrostrain
{
  substrate = substr
}

efaschroedinger
{
  x-periodicity = false
  Dirichlet_bc_everywhere = true
  # particle = hl
  number_of_eigenstates = 30
  # model = conduction_band #eff mass cb
  poisson_model_name = driftdiffusion # potential from driftdiffusion
  strain_model_name = macrostrain
  convergent_density = true
4.9. EXAMPLE OF INPUT FILE

```{quantum_electrons
  particle = el
}
```

```{quantum_holes
  particle = hl
}
```

```#
  # Definition of Model dependent physical parameters
  $Physics
  {
    driftdiffusion
    {
      statistics = FD

      strain_simulation = macrostrain # default driftdiffusion model including
      # local strain obtained from "macrostrain"
    }
    quantum_electrons
    {
      particle = el
      model = conduction_band  # eff mass cb
    }
    quantum_holes
    {
  ```
particle = hl
model = kp  # k.p for valence band
kp_model = 6x6

# Definition of model-indipendent parameters of the Simulation

$Simulation
{

  searchpath = ../../../materials

  mesh_units = 1e-9  #nm !!
  dimension = 1
  meshfile = test.msh
  temperature = 300
  solve = (strain, driftdiffusion, quantum_electrons, quantum_holes )

  resultpath = output_

  plot = (Ec, Ev, QFermi_e, QFermi_h, EField ,
    eDensity, hDensity, eCurrent, hCurrent,
    Current, NetRecombination, eMob, hMob, T,
    strain, polarization, xEffPot, xDensity,
    xMob, ExcitonRecombination, EigenFunctions,
    EigenEnergy, EnergyLevels, xCurrent)

  output_format = grace

}
Chapter 5

Simulation of strain

5.1 Theory

The theoretical model of strain simulation can be found in Refs.\cite{1, 2}. The code can compute elastic deformations in a heterostructure and can calculate the deformed shape of the structure. The heterostructure can be either grown on a substrate or not. External pressure may be applied to a structure as well.

5.2 Models section parameters

The Models section looks like follows:

```plaintext
model macrostrain
{
    options
    {
        simulation_name = strain_in_transistor
        physical_regions = (2, 3, 4)
    }

    BC_Regions
    {
        .................
    }

}
```

53
There are three possible kinds of boundary conditions. The mandatory keyword
\[type = \{ \text{substrate} | \text{pressure} | \text{extended\_material}\}\]
specifies the boundary condition type.

### 5.2.1 Substrate boundary condition

In this case the boundary condition region (see 1.2) is the boundary between the device and the substrate. The substrate does not belong to the device. Therefore it is necessary to define both the boundary region number and the substrate material

**Role of substrate.** *In general, the “substrate” is a material that defines the lattice matching conditions, and not necessarily a real solid body on which the device is grown.*

\[
\text{BC\_Region layer\_of\_Al\_0.3\_Ga\_0.7\_N}
\{
    \text{BC\_reg\_numb = 14}
    \text{type = substrate}
    \text{mat = AlGaN}
    \text{x = 0.3}
    \text{structure = wz}
    \text{y\text{-growth\_direction} = (1,0,-1,0)}
    \text{z\text{-growth\_direction} = (-1,2,-1,0)}
    \text{x\text{-growth\_direction} = (0,0,0,1)}
\}
\]

### 5.2.2 External pressure boundary condition

The parameter *pressure* specifies the value (in GPa) of the normal pressure applied to the boundary region *BC\_reg\_numb*.

\[
\text{BC\_Region tip\_upon\_a\_surface}
\{
    \text{BC\_reg\_numb = 12}
    \text{type = pressure}
    \text{pressure = 12.3}
\}
\]

**Sign of pressure.** *The value of the pressure has a positive sign if the external force acts towards the surface, which in general has to be the boundary of a simulation environment.*
5.3. SOLVER PARAMETERS

5.2.3 Extended device boundary condition

If device that is grown on a substrate is very large we may want to simulate a part of it only. In this case the simulation domain boundary is not a free surface any more. The boundary conditions are as follows:

$$\int C_{ijkl} \frac{\partial u_k}{\partial x_k} n_id\Omega = 0 \quad (5.1)$$

The syntax is as follows:

```
BC_Region boundary1
{
    BC_reg_numb = 12
    type = extended_material
}
```

5.3 Solver parameters

The choice of the necessary parameters to be put in the Solver section depends on the type of the strain boundary condition for the structure, namely, if it is considered as grown on a substrate or not.

5.3.1 Structure with a substrate

The only mandatory parameter is substrate, to which a name of a substrate boundary condition region has to be assigned, e.g (referring to the previous example):

```
strain_in_transistor
{
    substrate = layer_of_Al_0.3_Ga_0.7_N
}
```

5.3.2 Structure without a substrate (freestanding)

In this case, the parameter substrate should not be present; instead, the following parameters should be defined.

- The reference lattice material is defined by the coordinates of a point belonging to this material, using the parameter reference_material_point.
As follows from Ref. [1], additional geometrical points have to be specified, according to the device dimensionality. The corresponding parameters are: fixed_point1, fixed_point2 and fixed_point3.

Since the elasticity energy is invariant with respect to translations and rotations of the structure, then, for the sake of uniqueness of solutions of the equations, another set of constraints is required. Hereafter we assume that a mesh is defined over the simulation domain and the displacement field \( u(\mathbf{r}) \) is defined at the mesh nodes.

Let \( D \) be the dimensionality of the structure minus the number of directions along which the structure is periodic. If \( D > 0 \), then a Dirichlet boundary condition is applied at an arbitrarily chosen node \( i_1 \):

\[
\mathbf{u}(\mathbf{r}_{i_1}) = \mathbf{0},
\]

in order to prevent the structure from undesirable translations. In the case of \( D > 1 \), another node \( i_2 \) is chosen and a constraint

\[
(\mathbf{u}(\mathbf{r}_{i_1}) - \mathbf{u}(\mathbf{r}_{i_2})) \cdot (\mathbf{r}_{i_1} - \mathbf{r}_{i_2}) = 0
\]

is applied, in order to keep the direction between the nodes \( i_1, i_2 \) unchanged. If \( D = 3 \), another node \( i_3 \) is chosen and additional constraint is set:

\[
(\mathbf{r}_{i_1} - \mathbf{r}_{i_2}, \mathbf{r}_{i_1} - \mathbf{r}_{i_3}, \mathbf{u}_{i_3}) = \mathbf{0},
\]

so the node \( i_3 \) has to belong to the \((\mathbf{r}_{i_1}, \mathbf{r}_{i_2}, \mathbf{r}_{i_3})\) plane.

Example for a 2D simulation:

```plaintext
strain_in_transistor
{
  reference_material_point = (0, 100, 0)
  fixed_point1 = (0, 0, 0)
  fixed_point2 = (10, 0, 0)
}
```

### 5.3.3 Additional parameters

**Numerical solver parameters**

- `tolerance`: relative tolerance of the iterative solver, e.g.
  
  ```plaintext
tolerance = 1e-10
  
  The default value is 1e-10.
```

- `ksp_type`: type of solver: `gmres`, `bcgsl`, `bcgs`, `cg`, `richardson`.
  
  ```plaintext
  ksp_type = type of solver: gmres, bcgsl, bcgs, cg, richardson.
  Default is:
  ```
5.3. SOLVER PARAMETERS

- \textbf{gmres} for 1D
- \textbf{bcgsl} for 2D and 3D

\[ pc = \text{type of pre-conditioner}: \text{ilu, composite, jacobi, lu, cholesky, eisenstat}. \]
Default is:

- \textbf{ilu} for 1D
- \textbf{jacobi} for 2D and 3D

\[ \text{max\_iterations} = \text{max number of iterations (default = 1000)} \]
\[ \text{monitor, xmonitor}: \text{if true, textual or graphical monitor of convergence process is enabled (default = false)} \]

Periodic boundary conditions

It is possible to specify periodic boundary conditions along the coordinate axes. The relative parameters are:

\[ \text{periodicity}_x = \{ \text{true} | \text{false} \} \]
\[ \text{periodicity}_y = \{ \text{true} | \text{false} \} \]
\[ \text{periodicity}_z = \{ \text{true} | \text{false} \} \]

The default value is \text{false}.

Mesh refinement

For the details about mesh refinement refer to the Libmesh library documentation. The parameter \text{refinement\_steps} defines the number of the refinement steps to be done (with default value equal to zero). The parameter \text{uniform\_refinement} = \{ \text{true} | \text{false} \} is used to choose between uniform and adaptive refinement. The default value is \text{false}, i.e. adaptive refinement. Example:

\[ \text{refinement\_steps} = 4 \]
\[ \text{refine\_fraction} = 0.25 \]
\[ \text{coarsen\_fraction} = 0 \]
\[ \text{max\_refinement\_level} = 10 \]

Deformed shape calculation

The displacement field and lattice matching parameters that are found from master equations can be used in order to define a new shape of the heterostructure. This new shape is the first approximation to the equilibrium one. The next approximations are
obtained iteratively by the following steps: at the $n$-th iteration the master equations are solved using the lattice matching deformation $\varepsilon_{ij}^n$ which is defined as

$$
\varepsilon_{ij}^n = \frac{1}{2} \left( \frac{\partial u_{i}^{n-1}}{\partial x_j} + \frac{\partial u_{j}^{n-1}}{\partial x_i} \right) + \varepsilon_{ij}^{n-1},
$$

where the displacement field $u^{n-1}$ has been taken from the iteration $n - 1$. Then the new shape is defined by using the displacements from the last step solution, and the iterative process is repeated until the displacement field vanishes and additional lattice parameters stabilise. The iterative cycle usually converges after 3 - 4 iterations.

The only parameter that controls shape calculation is `number_shape_steps`. The value defines number of iterations. The default value is zero, that means no shape deformation calculation.

### 5.4 Physics section parameters

There is a possibility to consider converse piezoelectric effect. For this it is necessary to specify a name of another simulation that can provide electric field. The parameter is `poisson_equation`. Example:

```
macrostrain
{
    poisson_equation = DriftDiffusion
}
```

**Interaction with other simulations.** *In order to take into account the converse piezoelectric effect, the poisson equation has to recalculate the necessary parameters after the strain simulation. To do so, the following parameters has to be set in the Physics section of the drift-diffusion equation (for details see Sec. 6.4):*

```
driftdiffusion
{
    model = strained
    strain_simulation = str
    recompute_band_parameters = true
}
```

### 5.5 Output

The output variables are:
• **strain** strain tensor (6 components) in calculation system

• **stress** stress tensor (6 components) in calculation system

• **polarization** piezo polarization vector (3 components) in calculation system

<table>
<thead>
<tr>
<th>Plot keyword</th>
<th>label</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>strain</td>
<td>eps</td>
<td>GPa</td>
</tr>
<tr>
<td>stress</td>
<td>stress</td>
<td></td>
</tr>
<tr>
<td>polarization</td>
<td>polarization</td>
<td>$C/cm^2$</td>
</tr>
</tbody>
</table>

**Table 5.1:** Elemental vector quantities

By using **StrainVariables** as a plot keyword it’s possible to include all quantities of the strain simulation.
Chapter 6

Drift-diffusion simulation of electrons and holes

6.1 Theory

The semi-classical transport simulation of electrons and holes is based on the drift-diffusion approximation (see e.g. [3]).

Beside the electric potential the electro-chemical potentials are used as variables such that the system of PDEs to be solved reads as follows

\[-\nabla (\varepsilon \nabla \phi - P) = -e(n - p - N_d^+ + N_a^-)\]
\[-\nabla (\mu_n n (\nabla \phi_n + P_n \nabla T)) = R\]
\[-\nabla (\mu_p p (\nabla \phi_p + P_p \nabla T)) = -R\]  \hspace{1cm} (6.1)

$P$ is the electric polarization due to e.g. piezoelectric effects and $R$ is the net recombination rate, i.e. recombination rate minus generation rate. $P_n$ and $P_p$ are the electron and hole thermoelectric power, respectively. The models for the mobilities and the net recombination rates can be specified in the `physical_model` sections as described in the following.

6.2 Plot variables

See tables 6.1, 6.2 and 6.3.

6.3 Models section

The `Models` section looks as given in Listing 3
Listing 3: Models section for drift-diffusion
6.3. MODELS SECTION

Nodal quantities

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Description</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ec</td>
<td>Conduction band edge</td>
<td>eV</td>
</tr>
<tr>
<td>Ec0</td>
<td>Conduction band edge without electric potential</td>
<td>eV</td>
</tr>
<tr>
<td>Ev</td>
<td>Valence band edge</td>
<td>eV</td>
</tr>
<tr>
<td>Ev0</td>
<td>Valence band edge without electric potential</td>
<td>eV</td>
</tr>
<tr>
<td>Eg</td>
<td>Band gap</td>
<td>eV</td>
</tr>
<tr>
<td>QFermi_e</td>
<td>Electro-chemical potential of electrons</td>
<td>eV (−eϕn)</td>
</tr>
<tr>
<td>QFermi_h</td>
<td>Electro-chemical potential of holes</td>
<td>eV (−eϕp)</td>
</tr>
<tr>
<td>EIPotential</td>
<td>Electric potential</td>
<td>V</td>
</tr>
<tr>
<td>eDensity</td>
<td>Electron density</td>
<td>cm⁻³</td>
</tr>
<tr>
<td>hDensity</td>
<td>Hole density</td>
<td>cm⁻³</td>
</tr>
<tr>
<td>eMob</td>
<td>Electron mobility</td>
<td>cm²V⁻¹s⁻¹</td>
</tr>
<tr>
<td>hMob</td>
<td>Hole mobility</td>
<td>cm²V⁻¹s⁻¹</td>
</tr>
<tr>
<td>Nd</td>
<td>Ionized donor density</td>
<td>cm⁻³</td>
</tr>
<tr>
<td>Na</td>
<td>Ionized acceptor density</td>
<td>cm⁻³</td>
</tr>
<tr>
<td>charge_density</td>
<td>Total charge density</td>
<td>cm⁻³</td>
</tr>
<tr>
<td>Pn</td>
<td>Electron thermoelectric power</td>
<td>V K⁻¹</td>
</tr>
<tr>
<td>Pp</td>
<td>Hole thermoelectric power</td>
<td>V K⁻¹</td>
</tr>
<tr>
<td>NetRecombination</td>
<td>The net recombination rate for each recombination model and the total rate</td>
<td>cm⁻³s⁻¹</td>
</tr>
</tbody>
</table>

Table 6.1: Nodal quantities

The physical_model sections can be omitted. In this case default models are used, namely no recombination/generation for the recombination model and constant mobility for the mobility models. There can be more than one recombination model.

6.3.1 Recombination models

This section describes the currently available generation/recombination models.

Shockley-Read-Hall (SRH) recombination

The SRH recombination model can be enabled in the input file by

```plaintext
physical_model recombination
{
    model = srh
    ...
}
```
**Elemental quantities**

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Description</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>EField</td>
<td>Electric Field</td>
<td>Vcm⁻¹</td>
</tr>
<tr>
<td>GradFermiE</td>
<td>Gradient of the electron electro-chemical potential</td>
<td>Vcm⁻¹</td>
</tr>
<tr>
<td>GradFermiH</td>
<td>Gradient of the hole electro-chemical potential</td>
<td>Vcm⁻¹</td>
</tr>
<tr>
<td>Current</td>
<td>Total current density</td>
<td>Acm⁻²</td>
</tr>
<tr>
<td>eCurrent</td>
<td>Electron current density</td>
<td>Acm⁻²</td>
</tr>
<tr>
<td>hCurrent</td>
<td>Hole current density</td>
<td>Acm⁻²</td>
</tr>
<tr>
<td>Polarization</td>
<td>Electric Polarization</td>
<td>Cm⁻²</td>
</tr>
<tr>
<td>GradPn</td>
<td>Gradient of electron thermolectric power</td>
<td>VK⁻¹cm⁻¹</td>
</tr>
<tr>
<td>GradPp</td>
<td>Gradient of hole thermolectric power</td>
<td>VK⁻¹cm⁻¹</td>
</tr>
</tbody>
</table>

**Table 6.2:** Elemental quantities

**Scalar quantities**

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Description</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>ContactCurrents</td>
<td>Contact currents</td>
<td><em>a</em></td>
</tr>
</tbody>
</table>

*a* depends on dimension and symmetry

**Table 6.3:** Scalar quantities

SRH recombination is defined as follows:

\[
R_{SRH} = \frac{np - n_i^2}{(n + n_i e^{E^*/k_B T}) \tau_p + (p + n_i e^{-E^*/k_B T}) \tau_n}
\]  

(6.2)

\(E^* = E_{trap} - (E_c + E_v)/2\) is the trap level with respect to the midband energy. \(n_i\) is the intrinsic carrier density, \(\tau_n\) and \(\tau_p\) are the recombination times. The parameters are taken from the material database. The recombination times are dependent on temperature and doping density, e.g.

\[
\tau_n = \tau_n^0 \left(\frac{T}{T_0}\right)^{\alpha_n} e^{\beta n_0 T_0^{-1}}
\]  

(6.3)

\[
\tau_n^0 = \tau_{min,n} + \frac{\tau_{max,n} - \tau_{min,n}}{1 + (N/N_{ref})^\gamma}
\]  

(6.4)

where \(T_0\) is the reference temperature (300 K). Table 7.2 shows the corresponding parameters for the material data files. The parameters for holes and electrons have to be specified in an array, e.g. \(taumin = (1e-5, 3e-6)\)
6.3. MODELS SECTION

<table>
<thead>
<tr>
<th>parameter</th>
<th>keyword</th>
</tr>
</thead>
<tbody>
<tr>
<td>$\tau_{min}$</td>
<td>taumin</td>
</tr>
<tr>
<td>$\tau_{max}$</td>
<td>taumax</td>
</tr>
<tr>
<td>$N_{ref}$</td>
<td>Nref</td>
</tr>
<tr>
<td>$\gamma$</td>
<td>gamma</td>
</tr>
<tr>
<td>$E^*$</td>
<td>Etrap</td>
</tr>
<tr>
<td>$\alpha$</td>
<td>Talpha</td>
</tr>
<tr>
<td>$\beta$</td>
<td>Tcoeff</td>
</tr>
</tbody>
</table>

Table 6.4: SRH material data file parameters

The recombination times and trap level can be overridden from the input file by using the keywords of table 6.5 in the appropriate physical_model section or in the Region section (the latter overrides the former).

\[
tau_n \quad \text{tau}_n \\
tau_p \quad \text{tau}_p \\
E^* \quad E_t
\]

Table 6.5: SRH input file parameters

**Direct (radiative) recombination**

The direct recombination model can be enabled in the input file by

```plaintext
physical_model recombination
{
    model = direct
    ...
}
```

Direct recombination is modeled as follows:

\[
R_{direct} = C(np - n_i^2) \quad (6.5)
\]

The material data file and the input file use the same keyword $C$ for the parameter $C$. The database value can be overridden from the input file as described for SRH recombination.

**Auger recombination**

The Auger recombination model can be enabled in the input file by
Auger recombination is modeled by the following equation

$$R_{\text{auger}} = (C_n n + C_p p)(n p - n_i^2)$$

with temperature dependent parameters

$$C_{\{n,p\}} = \left( A + B \frac{T}{T_0} + C \left( \frac{T}{T_0} \right)^2 \right) \left( 1 + H e^{-(n,p)/N_0} \right)$$

The parameters $A, B, C, H$ and $N_0$ are taken exclusively from the database. They are different for $C_n$ and $C_p$ and have to be specified as arrays with keywords $A, B, C, H, N0$, e.g. $A = (1e^{-31}, 1e^{-32})$. The calculated values for $C_n$ and $C_p$ can be overridden from the input file by specifying values for the keywords $Cn$ and $Cp$.

### 6.3.2 Thermoelectric power models

The thermoelectric power models are the same for electrons and holes. The keyword is `thermoelectric_power`, i.e.

```plaintext
physical_model thermoelectric_power
{
    model = ...
}
```

The model keyword can be `constant` (i.e. the thermoelectric powers are read from the database) or `diffusivity_model` where the thermoelectric powers are computed by

$$P_n = -\frac{k_b}{q} \left( \frac{5}{2} + \frac{e\phi_n + E_c - e\varphi}{k_b T} \right)$$

$$P_p = \frac{k_b}{q} \left( \frac{5}{2} - \frac{e\phi_p + E_v - e\varphi}{k_b T} \right)$$

The default is $P_n = P_p = 0$. 


6.3. MODELS SECTION

6.3.3 Mobility models

Mobility models have currently to be defined for electrons and holes independently. The corresponding keywords are electron_mobility and hole_mobility, i.e.

physical_model electron_mobility
{
  model = ...
  ...
}

physical_model hole_mobility
{
  model = ...
  ...
}

The default model is the constant mobility model. The parameters for the different mobility models are needed for both electrons and holes. In the material files they are specified with a common keyword in arrays, e.g.

[mobility/constant]
  #   electrons holes
  mu_max = (1400.0, 250.0)
  exponent = (1.0, 2.1)

Constant mobility model

The constant mobility model (identifier constant) assumes a mobility which depends only on temperature by means of the following formula:

\[ \mu_{\text{const}} = \mu_0 \left( \frac{T}{T_0} \right)^{-\gamma} \] (6.9)

In the material data file \( \mu_0 \) and \( \gamma \) have to be specified with the keywords mu_max and exponent. \( \mu_0 \) can be overridden from the physical_model section using the keyword mu or from the Region sections using the keywords mu_e and mu_h.

Doping dependent mobility model

The doping dependent mobility model (identifier doping_dependent) implements two models for mobility depending on the total doping density and the temperature. The model that is used depends on the value of the mobility_formula parameter.
Model by Masetti et al. [4]
The model by Masetti et al. is identified by \textit{mobility\_formula} = 1. It uses the following formula:

\[
\mu = \mu_{\text{min},1} \cdot e^{-P_c/N} + \frac{\mu_{\text{const}} - \mu_{\text{min},2}}{1 + (N/C_r)^\alpha} - \frac{\mu_1}{1 + (C_s/N)^\beta}
\]  

where \(N\) is the total doping density and \(\mu_{\text{const}}\) the mobility obtained from the constant mobility model. The parameters are specified in the material file as given in table 6.6.

<table>
<thead>
<tr>
<th>parameter</th>
<th>keyword</th>
</tr>
</thead>
<tbody>
<tr>
<td>(\mu_{\text{min},1})</td>
<td>mumin1</td>
</tr>
<tr>
<td>(\mu_{\text{min},2})</td>
<td>mumin2</td>
</tr>
<tr>
<td>(\mu_1)</td>
<td>mul</td>
</tr>
<tr>
<td>(P_c)</td>
<td>Pc</td>
</tr>
<tr>
<td>(C_r)</td>
<td>Cr</td>
</tr>
<tr>
<td>(C_s)</td>
<td>Cs</td>
</tr>
<tr>
<td>(\alpha)</td>
<td>alpha</td>
</tr>
<tr>
<td>(\beta)</td>
<td>beta</td>
</tr>
</tbody>
</table>

\textbf{Table 6.6:} Data file parameters for the mobility model by Masetti et al.

Model by Arora [5]
The model by Arora is identified by \textit{mobility\_formula} = 2. It reads:

\[
\mu = \mu_{\text{min}} + \frac{\mu_d}{1 + (N/N_0)^{\alpha_d}}
\]  

with

\[
\mu_{\text{min}} = A_{\text{min}}(T/T_0)^{\alpha_m}, \quad \mu_d = A_d(T/T_0)^{\alpha_d}
\]

\[
N_0 = A_N(T/T_0)^{\alpha_N}, \quad A^* = A_\alpha(T/T_0)^{\alpha_\alpha}
\]

The parameters are given in table 6.7.

Field dependent mobility model

The field dependent mobility model describes the degradation of mobility at high driving fields. It is identified by the identifier \textit{field\_dependent}. The electric field component in direction of the current flow or the gradient of the electro-chemical potential can be chosen as driving force:

\textit{driving\_force} = \textit{efield} | \textit{grad\_fermi}
The default driving force is the gradient of the electro-chemical potential.

The model is based on the Caughey-Thomas model, refined by Canali [6]:

\[
\mu = \frac{\mu_{\text{lowfield}}}{\left(1 + \left(\frac{\mu_{\text{lowfield}}|E|}{v_{\text{sat}}}ight)\beta\right)^{1/\beta}}
\]  

(6.12)

with

\[\beta = \beta_0 (T/T_0)^b\]

|E| is the modulus of the driving field, \(\mu_{\text{lowfield}}\) is the low-field mobility. For the latter one can specify the model to be used using the parameter \text{lowfield\_model}. As default the doping dependent model is used.

There are two models for \(v_{\text{sat}}\), identified with \text{Vsat\_Formula = 1 and 2}. Formula 1 reads

\[v_{\text{sat}} = v_{\text{sat},0}(T/T_0)^{-\gamma}\]

Formula 2 reads

\[v_{\text{sat}} = \max(A_{v_{\text{sat}}} - B_{v_{\text{sat}}}(T/T_0), v_{\text{min}})\]

The parameters for the field dependent mobility model are summarized in table 6.8.

### 6.3.4 Boundary conditions

Boundary conditions are implemented for ohmic contacts, Schottky contacts, free surfaces and interfaces. Contacts are boundary models that allow a nonzero normal electrical current. For this type of boundaries one can define a contact resistance using the \text{contact\_resistance} option. The contact resistance has units \(\Omega\text{cm}^2\). The applied voltage is specified with the option \text{voltage}. A variable can be assigned to this, using the \$\text{-}\$-syntax.
Table 6.8: Data file parameters for the mobility model by Arora.

For a finer control of the behaviour at electrical contacts, the options `zero_field`, `zero_grad_fermi_e` and `zero_grad_fermi_h` can be used, which when set to `true` will impose zero normal electric field and zero normal gradient of the electron and hole electro-chemical potential, respectively. The ohmic contact (identifier `ohmic`) has no further parameters.

A Schottky contact (identifier `schottky`) has the additional parameter `barrier`, which signifies the energy difference between the semiconductor band edge and the fermi energy in the metal. As default, the barrier is taken with respect to the conduction band. By specifying `band = v` the barrier can be imposed with respect to the valence band (p-type contact). Alternatively, the metal work function can be defined using the keyword `work_function`. Note, however, that its value has to be aligned with the band energies given in the material files for the other materials.

If a contact touches several different regions with different materials, it can be necessary to provide a reference material using the keyword `reference_material` and specifying the name of a TIBERCAD region. TIBERCAD will prefer semiconductors over dielectrics if no reference material is specified.

The type of boundary model is chosen by the parameter `type`, e.g. `type = schottky`.

The free surface or interface model (identifier `interface`) models surface charges and surface recombination. Two modes are possible for the surface charge model:

**constant charge** a constant charge can be assigned by specifying only the sheet carrier density $N_s$ in cm$^{-2}$. The sheet charge density will then equal $N_s$ multiplied by the elementary charge $e$. A positive $N_s$ produces a positive surface charge.

**electronic surface states** in this case the surface charge is produced by electrons occupying a surface state with a density of states in form of a delta function. The density of occupied states then reads

$$n_s = \frac{N_s}{1 + \frac{1}{g} \exp\left(\frac{E_c - \Delta E - e\phi + e\phi_n}{k_B T}\right)}$$
The density of states \( N_s \) is specified by \( N_s \), the energy of the state with respect to the conduction band \( \Delta E_s \) by \( E_s \). \( g \) denotes the multiplicity of the state and defaults to 2. It can be changed by assigning a value to \( g \).

Surface recombination is switched on by setting the keyword surface_rec to true. The model used for surface recombination is formally the same as the bulk SRH recombination. However, the only parameters are the recombination velocities, which have to be specified (in cm/s) in the input file using the keywords rec_vel_e and rec_vel_h.

### 6.4 Physics section

Options for controlling the drift-diffusion semiconductor models can be specified in the Physics section. The corresponding parameters are given in table 6.9. When model is not specified, the default semiconductor model based on bulk \( \mathbf{k} \cdot \mathbf{p} \) theory is used.

The electron_quantum_density and hole_quantum_density will use the particle densities calculated from the corresponding quantum_density simulation. In regions where no quantum density is available, the classical density will be used. The electron_quantum_density and hole_quantum_density keywords can be used also in the Region sections to be able to use different quantum density simulations in different regions. For further options regarding selfconsistent Schrödinger-Poisson/Drift-Diffusion calculations see Sec. 6.4.3.

<table>
<thead>
<tr>
<th>keyword</th>
<th>possible values</th>
<th>description</th>
</tr>
</thead>
<tbody>
<tr>
<td>model</td>
<td>(see following subsections)</td>
<td>the model to use for the description of the conduction and valence band properties</td>
</tr>
<tr>
<td>statistics</td>
<td>B</td>
<td>FD</td>
</tr>
<tr>
<td>strain_simulation</td>
<td>name</td>
<td>the strain simulation to be used</td>
</tr>
<tr>
<td>thermal_simulation</td>
<td>name</td>
<td>the thermal simulation to be used</td>
</tr>
<tr>
<td>electron_quantum_density</td>
<td>name</td>
<td>the quantum density simulation to be used for the electron density</td>
</tr>
<tr>
<td>hole_quantum_density</td>
<td>name</td>
<td>the quantum density simulation to be used for the hole density</td>
</tr>
</tbody>
</table>

**Table 6.9:** Common options for the drift-diffusion semiconductor models.
The \texttt{strain_simulation} option is used to specify the simulation that provides strain in the case of strained systems. If it is omitted, an unstrained system is assumed for the drift-diffusion calculation.

The \texttt{thermal_simulation} option is used to specify the simulation that provides the lattice temperature for non-isothermal simulations. If it is omitted, the simulation temperature as provided in the \texttt{Simulation} section of the input file (or, if not provided, the default value of 300 K) is used.

### 6.4.1 Simple semiconductor model

When specifying \texttt{model = simple} a very simple semiconductor model is used. For this model one has to provide conduction and valence band edges and the effective density of states masses in the \texttt{Region} sections. The corresponding keywords are given in table 6.10.

<table>
<thead>
<tr>
<th>keyword</th>
<th>description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ec</td>
<td>conduction band edge (eV)</td>
</tr>
<tr>
<td>Ev</td>
<td>valence band edge (eV)</td>
</tr>
<tr>
<td>m_dos_e</td>
<td>conduction band effective DOS mass (m_e)</td>
</tr>
<tr>
<td>m_dos_h</td>
<td>valence band effective DOS mass (m_e)</td>
</tr>
</tbody>
</table>

Table 6.10: Parameters for the simple semiconductor model

### 6.4.2 Default semiconductor model

The default semiconductor model uses a bulk \texttt{k\_p} model to calculate the band parameters. It can be chosen explicitly by \texttt{model = default}. The model reads all needed parameters from the material data file.

The band parameters are calculated considering locally strain and lattice temperature as obtained from the corresponding simulations specified using the \texttt{strain_simulation} and \texttt{thermal_simulation} keywords.

### 6.4.3 Special options for Schrödinger-Poisson calculations

\textsc{TiberCAD} is able to do selfconsistent Schrödinger-Poisson or Schrödinger-Drift-Diffusion calculations. For this purpose, \texttt{electron_quantum_density} or \texttt{hole_quantum_density} has to be specified for at least one region, and a selfconsistent simulation should be defined in the \texttt{Selfconsistent} block. The following options – to be specified in the \texttt{Physics} section – control the behaviour of the selfconsistent simulation.
use_density_predictor = bool When set to true, a predictor-corrector scheme will be adopted in the selfconsistent cycle. The Poisson/Drift-Diffusion solver does not just take the particle densities as given by the Schrödinger calculation, but it will assume a dependency of the density on the potentials of the form

$$\rho(\varphi, \phi_n, \phi_p) = \frac{\rho_{\text{quantum}}(\varphi^0, \phi_n^0, \phi_p^0)}{\rho_{\text{classical}}(\varphi^0, \phi_n^0, \phi_p^0)} \rho_{\text{classical}}(\varphi, \phi_n, \phi_p)$$  \hspace{1cm} (6.13)

where \((\varphi^0, \phi_n^0, \phi_p^0)\) are the potentials for which the quantum density was calculated. use_density_predictor = true is the preferred method for selfconsistent Schrödinger-Poisson/Drift-Diffusion calculations, however it is not enabled by default.

eembracing_length = double When the domain of the quantum simulation is smaller than the domain of the full simulation, the boundary conditions for the Schrödinger equation will disturb the transfer from classical to quantum density. By defining an embracing region of a certain extension (specified in meters), a gradual transition from classical to quantum density will be done instead of an abrupt one, using as effective density \(\rho = x \cdot \rho_{\text{quantum}} + (1 - x) \cdot \rho_{\text{classical}}\). The default is no embracing region at all (zero extension).

cutoff = double If an embracing region is used, a part of this region near the boundary of the quantum region can be cut off so that only the classical density is considered in that part. cutoff is specified as a percentage of the embracing length and should therefore be between 0.0 and 1.0.

plot_embracing_regions = bool Whereas the automatic creation of the embracing region in 1D is a very simple task, it is a more difficult one in higher dimensions. By setting this flag to true, the embracing region and the mixing coefficient \(x\) will be plotted for a visual control of the quality of the embracing region. The default is false.

6.5 Solver section

Many of parameters for the numerical solver depend on the type of solver being used and on the device to be simulated. Table 6.11 lists the options that are independent on the type of solver used.

The linear and nonlinear solvers to be used can be chosen using the keywords linear_solver and nonlinear_solver, respectively. For the nonlinear solver one can chose between the PETSc implementation (petsc) and the TiberCAD implementation (tiber) of line search. When using the TiberCAD nonlinear solver, one can additionally chose between
### Table 6.11: Solver independent parameters

<table>
<thead>
<tr>
<th>keyword</th>
<th>description</th>
</tr>
</thead>
<tbody>
<tr>
<td>coupling</td>
<td>defines which equations to couple together. poisson: solve only poisson eq., electrons: electrons and poisson, holes: holes and poisson, current: only electron and hole currents, &lt;full&gt;: the fully coupled system</td>
</tr>
<tr>
<td>el_qfermi_level</td>
<td>the spatially constant electrochemical potential for the electrons (for quasi-equilibrium calculations)</td>
</tr>
<tr>
<td>hl_qfermi_level</td>
<td>the spatially constant electrochemical potential for the holes (for quasi-equilibrium calculations)</td>
</tr>
<tr>
<td>integration_order</td>
<td>order of the numerical gauss integration. Default is 2</td>
</tr>
<tr>
<td>current_integration_method</td>
<td>method for the calculation of the contact currents. surfint: integrate the local current density over the contact surface, &lt;rstf&gt;: use the Ramo-Shockley test functions, gives better results</td>
</tr>
<tr>
<td>local_scaling</td>
<td>apply a local scaling scheme which leads to better scaled matrices. &lt;true&gt; or false</td>
</tr>
<tr>
<td>exact_newton</td>
<td>use exact or approximate (without some parts in the jacobian) Newton. &lt;true&gt; or false</td>
</tr>
</tbody>
</table>

*the default is given in brackets*
6.5. SOLVER SECTION

6.5.1 Parameters for PETSc solvers

Tables 6.12 and 6.13 list all solver parameters significant for the PETSc linear and nonlinear solvers. A more detailed description of the most important parameters follows.

<table>
<thead>
<tr>
<th>keyword</th>
<th>description</th>
<th>default</th>
</tr>
</thead>
<tbody>
<tr>
<td>nonlin_rel_tol</td>
<td>relative tolerance for the residual $l_2$-norm</td>
<td>10e-9</td>
</tr>
<tr>
<td></td>
<td>(with respect to first nonlinear step)</td>
<td></td>
</tr>
<tr>
<td>nonlin_abs_tol</td>
<td>absolute tolerance for the residual $l_2$-norm</td>
<td>10e-15</td>
</tr>
<tr>
<td>nonlin_step_tol</td>
<td>tolerance for the $l_2$-norm of the nonlinear</td>
<td>10e-3</td>
</tr>
<tr>
<td></td>
<td>step</td>
<td></td>
</tr>
<tr>
<td>ls_max_step</td>
<td>the maximum $l_2$-norm for the line search</td>
<td>1</td>
</tr>
<tr>
<td></td>
<td>step, in units of eV</td>
<td></td>
</tr>
<tr>
<td>nonlin_max_it</td>
<td>maximum number of nonlinear iterations</td>
<td>20</td>
</tr>
</tbody>
</table>

Table 6.12: Parameters for the PETSc nonlinear solver

<table>
<thead>
<tr>
<th>keyword</th>
<th>description</th>
<th>default</th>
</tr>
</thead>
<tbody>
<tr>
<td>ksp_type</td>
<td>the linear solver type</td>
<td>bcgs1</td>
</tr>
<tr>
<td>pc_type</td>
<td>the preconditioner type</td>
<td>ilu</td>
</tr>
<tr>
<td>lin_rel_tol</td>
<td>relative tolerance for the linear solver</td>
<td>1e-6$^*$</td>
</tr>
<tr>
<td>lin_abs_tol</td>
<td>absolute tolerance for the linear solver</td>
<td>10e-50</td>
</tr>
<tr>
<td>lin_max_it</td>
<td>maximum number of linear iterations</td>
<td>500</td>
</tr>
</tbody>
</table>

$^*$The linear tolerance gets automatically decreased after each nonlinear step.

Table 6.13: Parameters for the PETSc linear solver

The ksp_type specifies the type of Krylov subspace method to be used. The mostly used methods are

- bcgs A stabilized version of the biconjugate gradient method. This one works better in 1D than bcgs1.
- bcgs1 (default) A modified version of bcgs.
- gmres Generalized minimal residual method.

The pc_type specifies the type of preconditioner to be used. The most useful ones are
CHAPTER 6. DRIFT-DIFFUSION SIMULATION OF ELECTRONS AND HOLES

ilu (default) Incomplete LU factorization. Does not work for materials with high band gap.

jacobi Jacobi preconditioning (diagonal scaling).

composite Combination of ilu and jacobi.

The ls_max_step parameter defines an upper bound of the $l_2$-norm of the nonlinear line search step. It should be not too big to prevent the algorithm from diverging, but also not too small to minimize the number of iterations. Values between 1 and 10 should be a good choice.

The nonlin_step_tol defines at which line search step size (in $l_2$-norm) the algorithm stops, i.e. assumes to have reached convergence. nonlin_step_tol is measured in eV.

### 6.5.2 Parameters for the TIBERCAD nonlinear solver

Table 6.14 summarizes the parameters used for the TIBERCAD implementation of the line search algorithm.

<table>
<thead>
<tr>
<th>keyword</th>
<th>description</th>
<th>default</th>
</tr>
</thead>
<tbody>
<tr>
<td>nonlin_rel_tol</td>
<td>relative tolerance for the residual $l_2$-norm (with respect to first nonlinear step)</td>
<td>10e-9</td>
</tr>
<tr>
<td>nonlin_abs_tol</td>
<td>absolute tolerance for the residual $l_2$-norm</td>
<td>10e-15</td>
</tr>
<tr>
<td>nonlin_step_tol</td>
<td>tolerance for the maximum norm of the nonlinear step (eV)</td>
<td>10e-3</td>
</tr>
<tr>
<td>nonlin_max_it</td>
<td>maximum number of nonlinear iterations</td>
<td>20</td>
</tr>
</tbody>
</table>

**Table 6.14:** Parameters for the TIBERCAD line search

The stopping criterion based on the line search step uses the maximum norm of the nonlinear step, i.e. convergence is controlled locally. In addition to the parameters in table 6.14 one has to provide also parameters for the linear solver.

### 6.5.3 Parameters for the PARDISO linear solver

**NOTE:** the PARDISO linear solver is currently not included in the distribution. Currently the PARDISO interface has no adjustable parameters.
Chapter 7

Heat Balance simulation

The theoretical model of the heat balance problem can be found in Ref. [7].

7.1 Heat equation

The steady state heat equation with the continuity equation reads as

$$\nabla \cdot (-\kappa \nabla T) = H_S \tag{7.1}$$

where $T$ is the temperature, $\kappa$ is the thermal conductivity tensor and $H_S$ is the total heat source. The latter term is the sum of the heat sources specified by the submodels described below. The term between the brackets represents the thermal flux $J_q$.

7.2 Physical model

By neglecting particle effects, the thermal conductivity is only due to the lattice contribution. The lattice thermal conductivity is read from the database.

The thermal model is tagged as thermal. In options subsection we indicate the simulation name (simulation_name = whatever_you_want) and the simulation domain (physical_regions = wherever_you_want)

```plaintext
model thermal
{

  options
  {
    simulation_name = whatever_you_want
  }
```
physical_regions = wherever_you_want

...

7.2.1 Electron and hole dissipations

Electron and hole dissipations give the following heat source

\[ H_S = -\nabla \cdot [ (P_n T + \phi_n) J_n + (P_p T + \phi_p) J_p ] \]  

(7.2)

where \( P_n \) and \( P_p \) are the thermoelectric power of electrons and holes, respectively. \( \phi_n \) and \( \phi_p \) are the electro-chemical potentials.

The equation 7.2 represents several heat source contributions. Their estimates are reported in table 7.1.

<table>
<thead>
<tr>
<th>Expression</th>
<th>Heat source</th>
</tr>
</thead>
<tbody>
<tr>
<td>( J_n^2 )</td>
<td>Electron Joule effect</td>
</tr>
<tr>
<td>( J_p^2 )</td>
<td>Hole Joule effect</td>
</tr>
<tr>
<td>( qR_{SRH} (\phi_p - \phi_n + T (P_p - P_n)) )</td>
<td>Recombination effect</td>
</tr>
<tr>
<td>( -T J_n \cdot \nabla P_n )</td>
<td>Electron Peltier-Thomson effect</td>
</tr>
<tr>
<td>( -T J_p \cdot \nabla P_p )</td>
<td>Hole Peltier-Thomson effect</td>
</tr>
</tbody>
</table>

Table 7.1: Drift diffusion heat sources

The physical model **heat_source** includes a specific source identified by its **model** name. Concerning electron and hole dissipations the model is named **drift_diffusion_dissipation**, as reported below.

physical_model heat_source
{
  model = drift_diffusion_dissipation

  drift_diffusion_simulation = dd_simul_name
}

In order to include such a heat source we have to use a drift diffusion simulation. The syntax **drift_diffusion_simulation = dd_simul_name** allows this connection.
7.2. PHYSICAL MODEL

7.2.2 Boundary conditions

By default, thermally insulating surfaces are considered, i.e.

\[ \mathbf{J}_q \cdot \mathbf{N} = 0 \quad (7.3) \]

On the opposite side it is possible to include an ideal thermally conducting interface by fixing the temperature to the external one, i.e. :

\[ T = T_{ext} \quad (7.4) \]

This condition can be imposed with the following notation

\[
\text{BC_Regions} \\
\quad \{ \\
\quad \quad \text{BC Region name}_{\text{BC region}} \\
\quad \quad \{ \\
\quad \quad \quad \text{type} = \text{heat reservoir} \\
\quad \quad \quad \text{BC_reg_numb} = 3 \\
\quad \quad \quad \text{temperature} = 300 \\
\quad \quad \} \\
\quad \} 
\]

Once a \text{BC Region} is inserted in the \text{thermal} section, \text{heat reservoir} is the default \text{type}. The default \text{temperature} is the one indicated in the solve section.

Between such extreme situations, it is possible to take into account a thermally resistive interface, i.e.

\[ \mathbf{J}_q \cdot \mathbf{N} = G_s(T - T_{ext}) \quad (7.5) \]

where \( G_s \) is the thermal surface conductance and \( T_{ext} \) is the external temperature.

One can include this condition with the BC type \text{thermal_surface_conductance}:

\[
\text{BC_Regions} \\
\quad \{ \\
\quad \quad \text{BC Region name}_{\text{BC region}} \\
\quad \quad \{ \\
\quad \quad \quad \text{type} = \text{thermal_surface_conductance} \\
\quad \quad \quad \text{BC_reg_numb} = 3 \\
\quad \quad \quad \text{g_surf} = 0.01 \\
\quad \quad \quad \text{temperature} = 300 \\
\quad \quad \} \\
\quad \} 
\]
where $g_{\text{surf}}$ indicates $G_s$ and $\text{temperature}$ stands for $T_{\text{ext}}$.
Alternatively, it is possible to indicate the $R_s = 1/G_s$ quantity i.e. the thermal surface resistance. The notation is

\[
\text{BC}_\text{Regions} \\
\{ \\
\text{BC}\_\text{Region name}_{\text{BC}\_\text{region}} \\
\{ \\
\quad \text{type} = \text{thermal\_surface\_resistance} \\
\quad \text{BC}\_\text{reg\_numb} = 3 \\
\quad r_{\text{surf}} = 100 \\
\quad \text{temperature} = 300 \\
\} \\
\}
\]

Furthermore, it is possible to fix the normal thermal power density to a given value $J_{\text{ext}}$, i.e.

\[
J_q \cdot N = J_{\text{ext}} 
\] (7.6)

This condition is set with the BC type \text{thermal\_flux}:

\[
\text{BC}_\text{Regions} \\
\{ \\
\text{BC}\_\text{Region name}_{\text{BC}\_\text{region}} \\
\{ \\
\quad \text{type} = \text{thermal\_flux} \\
\quad \text{BC}\_\text{reg\_numb} = 3 \\
\quad \text{power\_density} = 100 \\
\}
\]

\section{Output data}

The variable labels are listed in the tables 7.3-7.5.

It is also possible to identify all heat sources with the keyword \text{HeatSource} and all power fluxes with \text{PowerFlux}. Finally, with the keyword \text{thermal} all quantities concerning the thermal simulation will be stored.
### 7.3. OUTPUT DATA

<table>
<thead>
<tr>
<th>description</th>
<th>type</th>
<th>parameters</th>
<th>units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ideal insulating interface</td>
<td>(Default)</td>
<td>(No parameters)</td>
<td></td>
</tr>
<tr>
<td>Ideal conducting interface</td>
<td>heat_reservoir</td>
<td>temperature</td>
<td>K</td>
</tr>
<tr>
<td>Resistive interface</td>
<td>thermal_surface_resistance</td>
<td>temperature</td>
<td>K</td>
</tr>
<tr>
<td>Resistive interface</td>
<td>thermal_surface_conductance</td>
<td>temperature</td>
<td></td>
</tr>
<tr>
<td>Power density condition</td>
<td>thermal_flux</td>
<td>power_density</td>
<td>Wcm⁻²</td>
</tr>
</tbody>
</table>

Table 7.2: Thermal boundary conditions

#### Nodal scalar quantities

<table>
<thead>
<tr>
<th>LatticeTemp</th>
<th>Temperature</th>
<th>K</th>
</tr>
</thead>
</table>

Table 7.3: Nodal scalar quantities

#### Elemental scalar quantities

<table>
<thead>
<tr>
<th>eJoule</th>
<th>Electron Joule effect</th>
<th>Wcm⁻³</th>
</tr>
</thead>
<tbody>
<tr>
<td>hJoule</td>
<td>Hole Joule effect</td>
<td>Wcm⁻³</td>
</tr>
<tr>
<td>RecHeat</td>
<td>Recombination heat</td>
<td>Wcm⁻³</td>
</tr>
<tr>
<td>ePelTh</td>
<td>Electron Peltier-Thomson effect</td>
<td>Wcm⁻³</td>
</tr>
<tr>
<td>hPelTh</td>
<td>Hole Peltier-Thomson effect</td>
<td>Wcm⁻³</td>
</tr>
<tr>
<td>TotalHeat</td>
<td>TotalHeat</td>
<td>Wcm⁻³</td>
</tr>
<tr>
<td>LatticeThermalCond</td>
<td>Lattice thermal conductivity</td>
<td>Wcm⁻¹K⁻¹</td>
</tr>
</tbody>
</table>

Table 7.4: Elemental scalar quantities

#### Elemental vector quantities

<table>
<thead>
<tr>
<th>Wq</th>
<th>Thermal flux</th>
<th>Wcm⁻²</th>
</tr>
</thead>
<tbody>
<tr>
<td>Wn</td>
<td>Electron power flux</td>
<td>Wcm⁻²</td>
</tr>
<tr>
<td>Wp</td>
<td>Hole power flux</td>
<td>Wcm⁻²</td>
</tr>
<tr>
<td>W</td>
<td>Total power flux</td>
<td>Wcm⁻²</td>
</tr>
</tbody>
</table>

Table 7.5: Elemental vector quantities
CHAPTER 7. HEAT BALANCE SIMULATION
Chapter 8

Envelope Function Approximation

The envelope function approximation (EFA) simulation tool of TIBERCAD is developed in order to solve a single-particle Schrödinger equation for electrons and holes in a semiconductor crystal. This problem is an eigenvalue problem that is treated as a generalized complex eigenvalue problem

\[ H\psi = S\psi, \]

where \( H \) and \( S \) are the Hamiltonian and \( S \)-matrix, respectively.

8.1 Models section parameters

The Models section looks like follows:

```plaintext
model efaschroedinger
{
    options
    {
        simulation_name = quantum_well1
        physical_regions = (1,2)
    }
}
```

The default boundary conditions of the simulation domain are open (that is zero flux for single-band calculation). It is possible to specify Dirichlet boundary conditions:

```plaintext
BC_Region infinite_barrier1
{
    BC_reg_numb = 12
}
```
type = Dirichlet
}

There is a way to impose automatically the Dirichlet boundary conditions over all the boundary of the simulation region. This is done by the parameter

\texttt{Dirichlet.bc\_everywhere = \{true | false\}} in \texttt{Solver} section. The default value for EFA problem is true.

8.2 Solver parameters

There are two groups of parameters. The first group is related to the general eigensolver problem, the second one is related to the Schrödinger equation.

8.2.1 Eigenvalue problem parameters

These parameters are common for all eigenvalue problems. Their default values may be different for different eigenvalue problems, for example for the Schroedinger equation and for the electromagnetic eigenvalue problem.

The eigenvalue problem can be solved by the solvers that are implemented into the SLEPc library. The relative parameter is

\texttt{solver = \{ arnoldi | lapack | krylovshur \}}. The default value is \texttt{krylovshur}.

In the case of the lapack solver all the eigenvalues are computed. In the case of arnoldi or krylovshur solver it is necessary to specify which and how many eigenvalues have to be computed. The idea is that the iterative solver calculates several eigenvalues that are close to a specific number, referred to as the \texttt{spectral\_shift}. The relative parameters are:

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>max_iteration_number</td>
<td>maximum number of iteration, used as a stop condition</td>
</tr>
<tr>
<td>eigen_solver_tolerance</td>
<td>numerical eigensolver tolerance used as a convergence criteria</td>
</tr>
<tr>
<td>spectral_shift</td>
<td>the closest eigenvalues to this value (eV) are found.</td>
</tr>
<tr>
<td>spectrum_inversion_tolerance</td>
<td>tolerance used for linear solver</td>
</tr>
</tbody>
</table>

\textbf{Table 8.1: Iterative eigensolver parameters}

If the spectral\_shift is not defined then it will be calculated internally from the band edges.

For the iterative solvers the important parameters, that may significantly change the performance, are the \texttt{Krylov subspace method} type and the \texttt{preconditioner} type.

The Krylov method is defined as follows:

\texttt{ksp\_type = \{ bcgs | gmres | bcgs | cg | richardson | preonly \}}
8.3. **PHYSICAL MODELS PARAMETERS**

The **preconditioner** type is defined as follows:

\[ pc_{\text{type}} = \{ \text{cholesky} \mid \text{jacobi} \mid \text{ilu} \mid \text{composite} \} \]

Other options:

- \[ x\text{-periodicity} = \{ \text{true} \mid \text{false} \} \]
- \[ y\text{-periodicity} = \{ \text{true} \mid \text{false} \} \]
- \[ z\text{-periodicity} = \{ \text{true} \mid \text{false} \} \]
- \[ \text{number of eigenstates} = \text{number of eigenstates to be computed} \]

### 8.2.2 Schrödinger equation parameters

- \[ \text{particle} = \{ \text{el} \mid \text{hl} \} \]; specifies a particle type, according to each the eigenvalues are sorted
- \[ \text{strain\_model\_name} = \text{name of the simulation that can provide elastic strain} \]
- \[ \text{poisson\_model\_name} = \text{name of the simulation that can provide electric and electrochemical potential} \]
- \[ \text{heat\_model} = \text{name of the simulation that can provide} \]
- \[ \text{relative\_density\_tolerance} = \text{relative tolerance for charge density calculation} \]
- \[ \text{initial\_eigenstates\_number} = \text{initial eigenstates number for charge density calculation} \]
- \[ \text{convergent\_density} = \{ \text{true} \mid \text{false} \} \] if true than number of eigenstates will be increased in order to reach convergent density.
- \[ \text{eigen\_number\_increase\_factor} = \text{factor to increase eigenvalues number for the next charge density calculation} \]

### 8.3 Physical Models parameters

- \[ \text{particle} = \{ \text{el} \mid \text{hl} \} \]
- \[ \text{model} = \{ \text{conduction\_band} \mid \text{kp} \} \] single conduction band (Γ point) or \( \mathbf{k} \cdot \mathbf{p} \).
- \[ \text{kp\_model} = \{ \text{6x6} \mid \text{8x8} \} \]
Here, the particle name is the name of a particle type (electron or hole). 

\( model = \text{kp} \mid \text{conduction_band} : \mathbf{k} \cdot \mathbf{p} \) or single conduction band model.

If \( \mathbf{k} \cdot \mathbf{p} \) model is applied, specify:

\( kp\_model = 6x6 \mid 8x8 \).

8.4 Output

- **EigenEnergy** Eigen energy in eV
- **EigenFunctions** \(|\psi(r)|^2\) function of the eigenstate
- **Occupation** probability to find the state occupied. It is calculated assuming Fermi distribution and mean electrochemical potential and temperature:

\[
\bar{\mu} = \langle \psi | \mu(r) | \psi \rangle \quad (8.2) \\
\bar{T} = \langle \psi | T(r) | \psi \rangle \quad (8.3)
\]
- **EnergyLevels** graphical output used for showing the energy level over the band diagram
Chapter 9
Simulation opticskp

By defining the opticskp model, calculation of optical properties is enabled; in particular, the optical kp matrix elements are calculated from the quantum models specified in Solver section:

```plaintext
opticskp
{
  initial_state_model = QW1_electrons # quantum_el
  final_state_model = QW1_holes # quantum_hl
  initial_eigenstates = (0, 19)
  final_eigenstates = (0, 19)
}
```

Here, initial_state_model and final_state_model are, respectively, the quantum models (efaschroedinger model) associated respectively to the initial state of optical transition (e.g. electron), and to the final state of optical transition (e.g. hole). initial_eigenstates and final_eigenstates refer to the range of eigenstates to be taken in account for optical calculations. By specifying, in Solver section, a range of energy values in this way:

- Emin = 3.0
- Emax = 5.0
- dE = 0.001

the emission optical spectrum for k=0 is calculated. The spectrum is calculated in the following way:

$$P(\hbar \omega) = \sum_{i,j} \frac{1}{2\pi^2 m^2 c^3} |M_{ij}|^2 \omega_i c^2 f_i(E_i)(1 - f_j(E_j)) \frac{\Gamma/2}{(\hbar \omega_{ij} - \hbar \omega)^2 + (\Gamma/2)^2} d\Omega,$$  \hspace{1cm} (9.1)

where $f_i$ and $f_j$ are the Fermi distributions.
9.1 Output

The output variables for optics calculations are:

- \texttt{optical\_spectrum\_k\_0} : optical emission spectrum for \(k=0\), calculated through \texttt{opticskp} model
Chapter 10

Simulation opticalspectrum

By defining the model **opticalspectrum**, optical matrix elements are used to calculate the associated (emission) spectrum with a k-space integration. In **Solver** section:

```plaintext
opticalspectrum
{
    k_space_dimension = 2
    k-space_basis = true
    k1 = (0, 0, 0.1)
    k2 = (0, 0.1, 0)

    refine_fraction = 0.30
    relative_accuracy = 0.01
    refine_k_space = true

    number_of_nodes = (2, 2)
    wedge = quarter

    optical_matr_elem_model = opticskp

    polarization = (0, 0, 1)

    Emin = 3.0
    Emax = 5.0
    dE = 0.001
}
```

The parameters:
CHAPTER 10. SIMULATION OPTICALSPECTRUM

$k_{\text{space\_dimension}} = 1$ for 2D simulations, 2 for 1D simulations. $k_{\text{-space\_basis}}$ is \textbf{true} if the k-space is defined by means of k-vectors; if \textbf{false}, vectors are expressed in real space.

If $\text{refine\_k\_space} = \text{true}$, that is adaptive k-mesh refinement is enabled, all the elements whose error is greater than the value $(1 - \text{refine\_fraction}) \times$ (maximum error) are going to be refined. In this case, 'Error' is just the integrated quantity. The refinement will end when the \textit{relative\_accuracy} is obtained.

- $\text{number\_of\_nodes}$ = numb. of elements in k mesh, along each direction
- $\text{wedge}$ = half | quarter, to reduce calculation time, by exploiting symmetry.
- $\text{optical\_matr\_elem\_model}$ = name of the \textit{opticskp} model associated
- $\text{polarization}$ = light polarization (vector)

$E_{\min}$, $E_{\max}$, $dE$ : energy range and step of spectrum calculation.

### 10.1 Output

The output variables for optics calculations are:

- \textbf{optical\_spectrum}: k-space integrated optical emission spectrum, calculated by \textit{opticalspectrum} model
Chapter 11

Quantum dispersion

There is a possibility to calculate the dependence of quantum eigenstates on \( k \)-vector. Such dependence is called dispersion. The simulation name is quantumdispersion. Example:

```plaintext
model quantumdispersion
{
  options
  {
    simulation_name = dispersion1D_el
    physical_regions = all
  }
}
```

11.1 Solver options

The dispersion of quantum states is calculated at \( k \)-points that are nodes of the mesh in \( k \)-space.

- **quantum_simulation** name of the Schrödinger equation simulation

- **min_eigenvalue_number, max_eigenvalue_number**: the dispersion is calculated for the states number \( i \), where
  
  \[ \text{max}_\text{eigenvalue}_\text{number} \geq i \geq \text{min}_\text{eigenvalue}_\text{number} \]

The rest of the parameters (wedge, k_space_dimension, etc...) define the \( k \)-space.
CHAPTER 11. QUANTUM DISPERSION

dispersion1D_el
{
    quantum_simulation = quantum_el
    min_eigenvalue_number = 0
    max_eigenvalue_number = 5

    wedge = half
    k_space_dimension = 1
    k1 = (0, 0.1, 0)
    number_of_nodes = (10)

    output_format = grace
}

11.2 Output

The output variable name is **k-space\_dispersion**. The output format for the dispersion can be controlled independently of the general specification in the Simulation section by redefining the output\_format keyword.
Chapter 12
Quantum Density

dens_el
{
  k_space_dimension = 2
  k-space_basis = true
  k1 = (0, 0, 0.1)
  k2 = (0, 0.1, 0)
  number_of_nodes = (4,4)
  wedge = quarter
  refine_fraction = 0.20
  relative_accuracy = 0.01
  refine_k_space = true
  uniform_refinement = false
  mesh_order = FIRST

  quantum_simulation = quantum_el
  degeneracy = 2
  initial_eigenstates_number = 10
  analitic = false
}

- **quantum_simulation** name of the Schrödinger simulation
- **degeneracy** degeneracy of the quantum state
- **initial_eigenstates_number** initial number of eigenstates for the Schrödinger equation
- **analytic** = { true | false } If true then the density is calculated analytically or numerically
Analysis calculation of density is done in the following way. For each eigenstate we calculate the effective mass assuming quadratic dispersion. Then the charge density is calculated as follows:

\[ \rho_{1D}(\mathbf{r}) = g \frac{mkT}{2\pi\hbar^2} |\psi(\mathbf{r})|^2 \ln \left( 1 + \exp \left( \pm \frac{\mu - E}{kT} \right) \right) \quad (12.1) \]

\[ \rho_{2D}(\mathbf{r}) = g |\psi(\mathbf{r})|^2 \frac{1}{2} \sqrt{\left( \frac{mkT}{2\pi\hbar^2} \right)} F_{-1/2} \left( \pm \frac{\mu - E}{kT} \right), \quad (12.2) \]

where \( \rho_{1D} \) and \( \rho_{2D} \) are the 1D and 2D charge densities; \( m \) is the averaged mass (the mass is different for each quantized state and is position independent); \( g \) is the degeneracy of the states. The \(+\) sign is for electrons, the \(-\) sign is for holes.

Numerical calculation is done by the following formula:

\[ \rho(\mathbf{r}) = \sum_n \frac{1}{(2\pi)^d} \int_{BZ} |\psi(\mathbf{r})|^2 \frac{1}{1 + \exp \left( \pm \frac{E - \mu}{kT} \right)} d\mathbf{k}_\parallel \quad (12.3) \]

The integration is performed on a mesh in the \( k \)-space.

### 12.1 Output

The output parameter is `quantum_density`. 
Bibliography


